

وَمَا أُوتِيتُمْ مِنَ الْعِلْمِ إِلَّا قَلِيلًا

# Analog IC Design

## Lecture 18 Noise

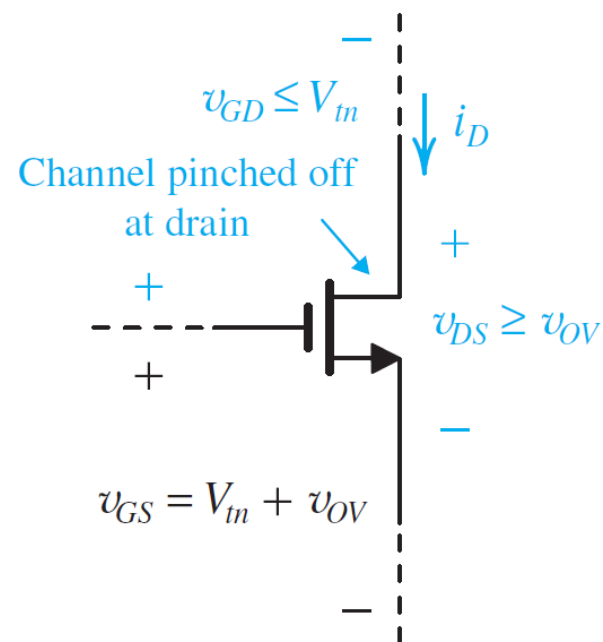
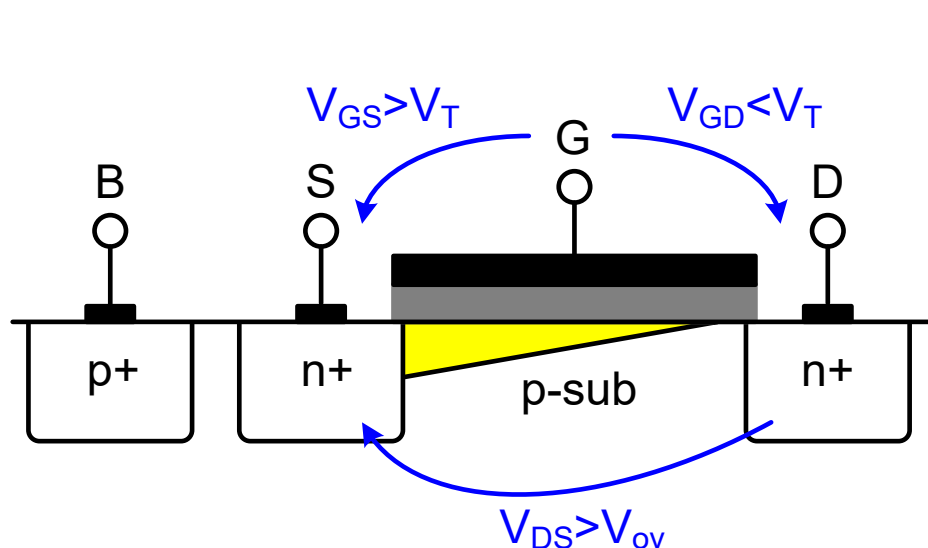
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# MOSFET in Saturation

- ❑ The channel is pinched off if the difference between the gate and drain voltages is not sufficient to create an inversion layer

$$I_D = \frac{\mu_n C_{ox}}{2} \frac{W}{L} \cdot V_{ov}^2 (1 + \lambda V_{DS})$$



# Regions of Operation Summary

**OFF**  
**(Subthreshold)**

$$V_{GS} < V_T$$

**ON**

$$V_{GS} > V_T$$

**Triode**

$$V_{DS} < V_{ov}$$

Or

$$V_{GD} > V_T$$

**Pinch-Off**  
**(Saturation)**

$$V_{DS} \geq V_{ov}$$

Or

$$V_{GD} \leq V_T$$

$$I_D = \mu C_{ox} \frac{W}{L} \left( V_{ov} V_{DS} - \frac{V_{DS}^2}{2} \right)$$

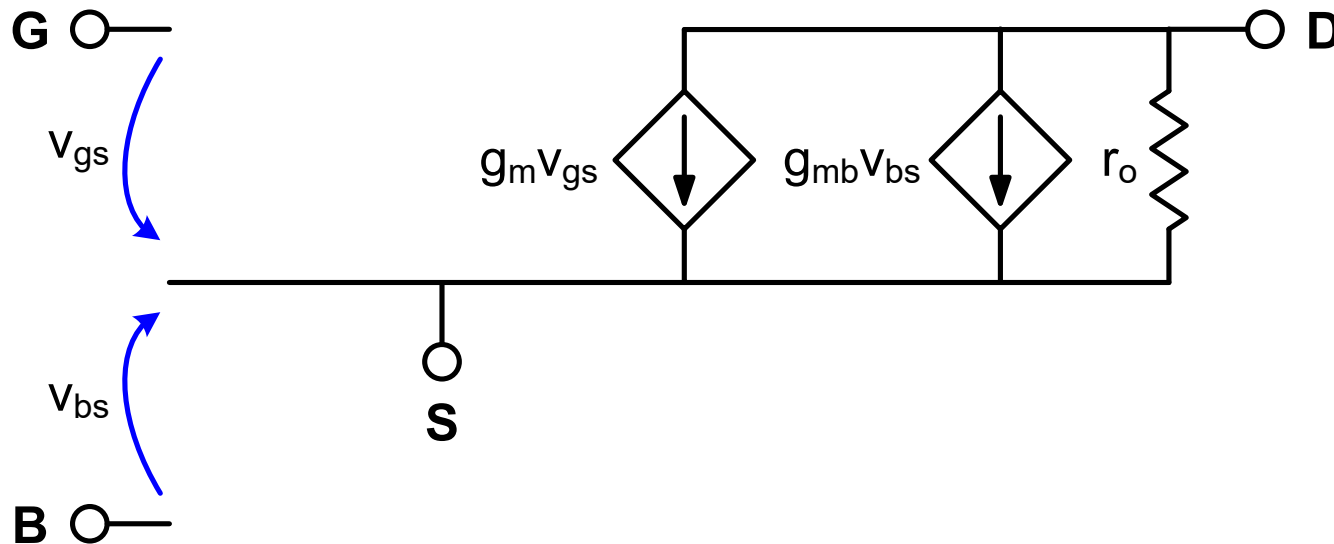
$$I_D = \frac{\mu C_{ox}}{2} \frac{W}{L} V_{ov}^2 (1 + \lambda V_{DS})$$

# Low-Frequency Small-Signal Model

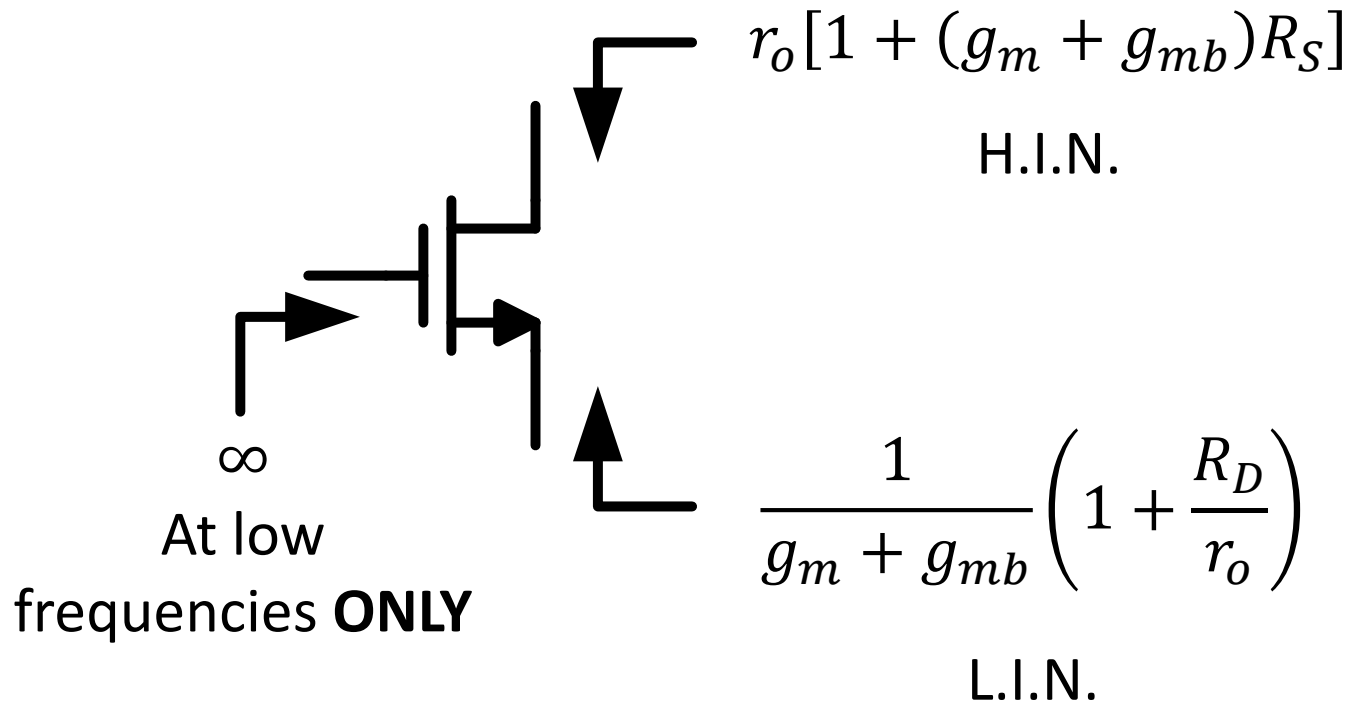
$$g_m = \frac{\partial I_D}{\partial V_{GS}} = \mu C_{ox} \frac{W}{L} V_{ov} = \sqrt{\mu C_{ox} \frac{W}{L} \cdot 2I_D} = \frac{2I_D}{V_{ov}}$$

$$g_{mb} = \eta g_m, \quad \eta \approx 0.1 - 0.25$$

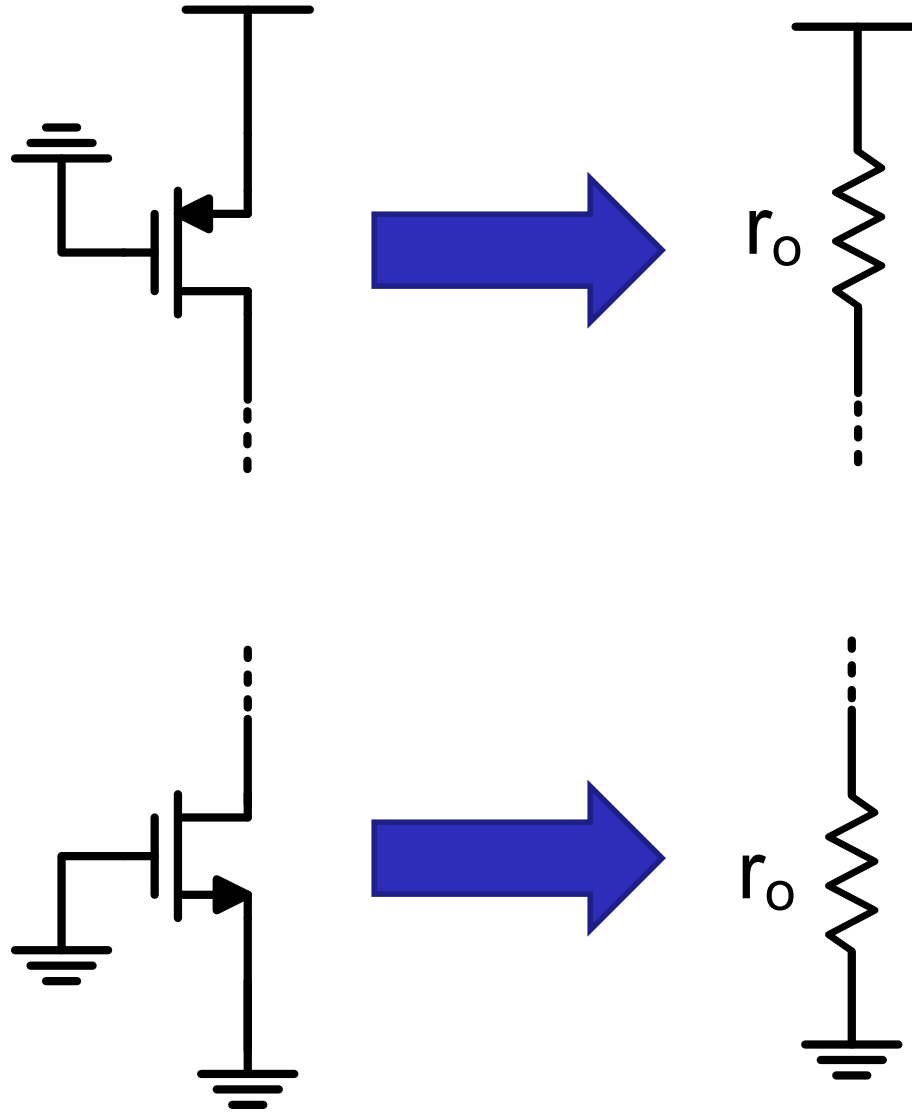
$$r_o = \frac{1}{\frac{\partial I_D}{\partial V_{DS}}} = \frac{1}{\lambda I_D}, \quad \lambda \propto \frac{1}{L}$$



# Rin/out Shortcuts Summary

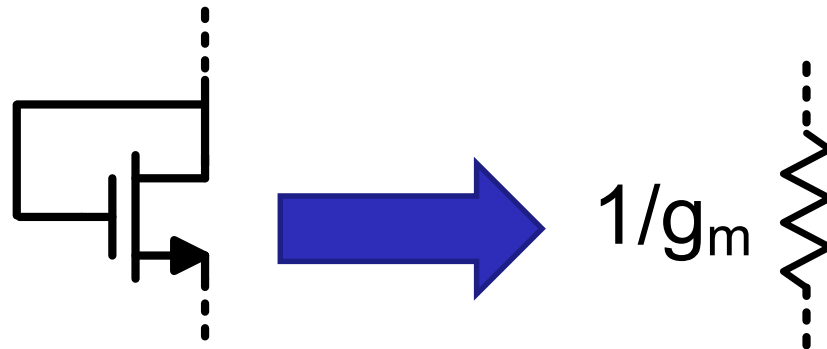
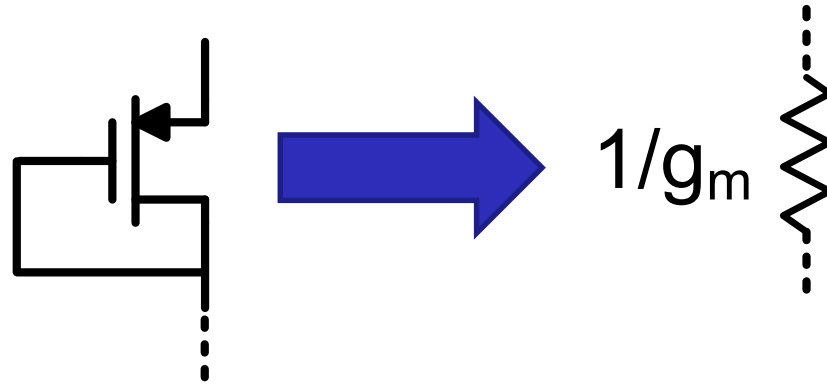


# Active Load (Source OFF)



# Diode Connected (Source Absorption)

- ❑ Always in saturation
- ❑ Bulk effect:  $g_m \rightarrow g_m + g_{mb}$



# Why GmRout?

$$R_{out} = \frac{v_x}{i_x} @ v_{in} = 0$$

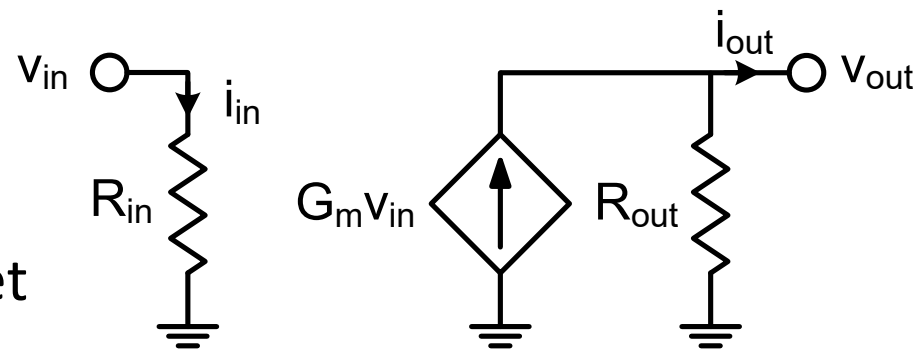
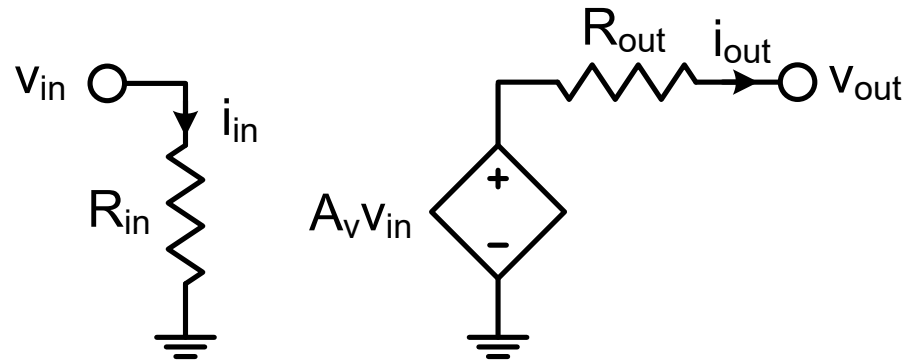
$$G_m = \frac{i_{out,sc}}{v_{in}}$$

$$A_v = G_m R_{out}$$

$$A_i = G_m R_{in}$$

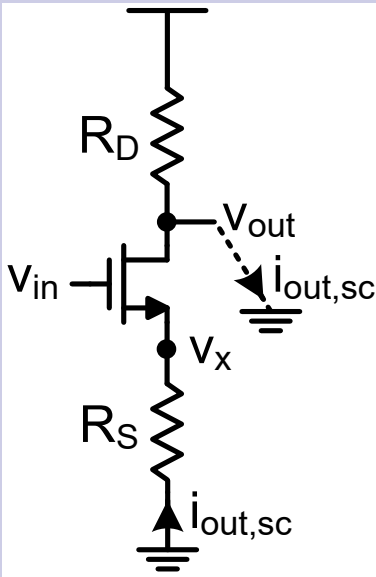
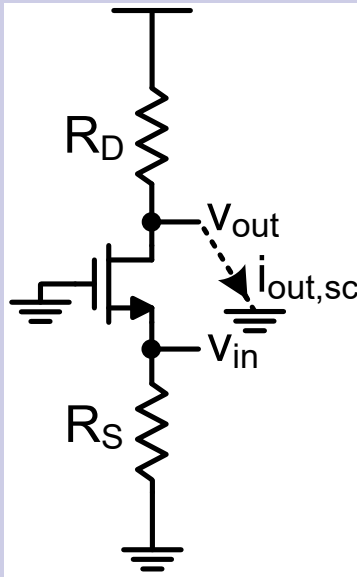
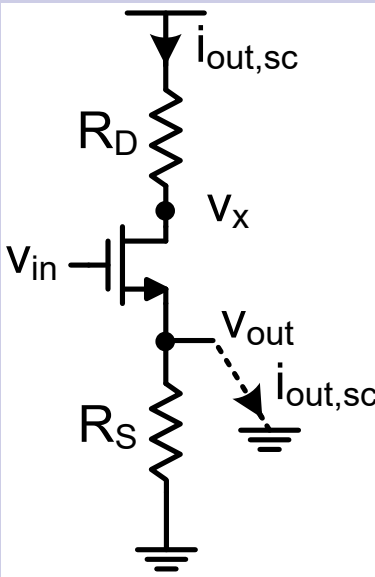
## □ Divide and conquer

- Rout simplified:  $v_{in}=0$
- Gm simplified:  $v_{out}=0$
- We already need Rin/out
- We can quickly and easily get Rin/out from the shortcuts





# Summary of Basic Topologies

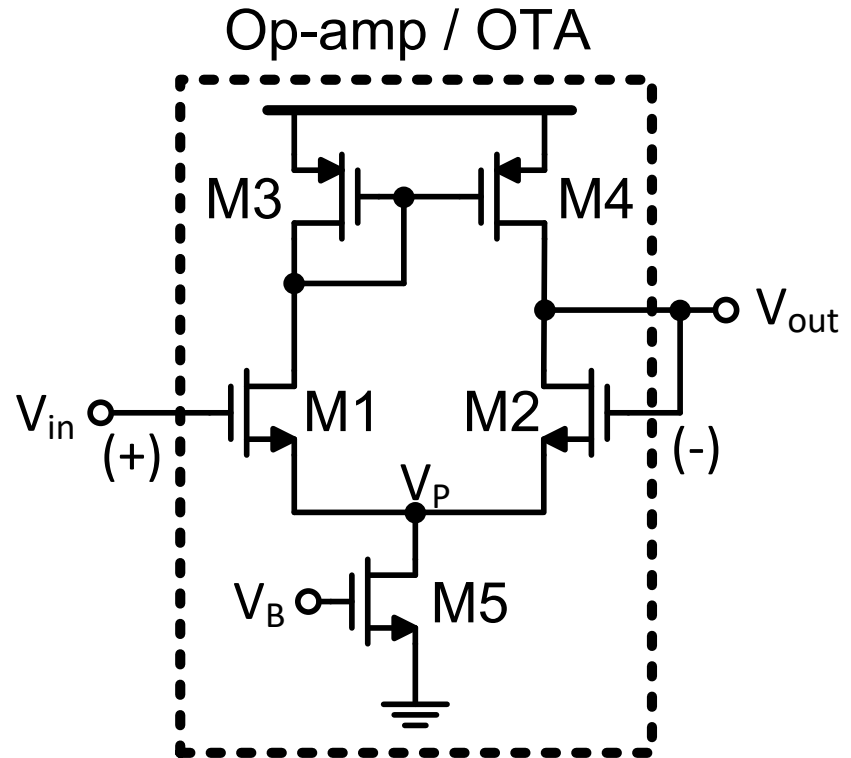
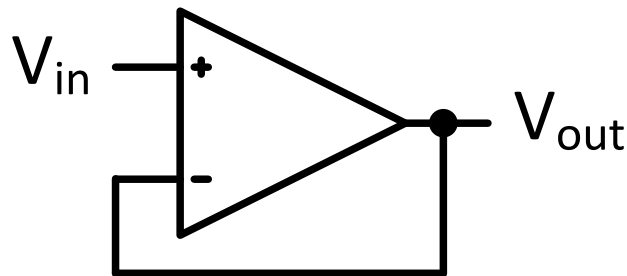
	CS	CG	CD (SF)
			
	Voltage & current amplifier	Current buffer	Voltage buffer
<b>Rin</b>	$\infty$	$R_S // \frac{1}{g_m + g_{mb}} \left( 1 + \frac{R_D}{r_o} \right)$	$\infty$
<b>Rout</b>	$R_D // r_o [1 + (g_m + g_{mb})R_S]$	$R_D // r_o$	$R_S // \frac{1}{g_m + g_{mb}} \left( 1 + \frac{R_D}{r_o} \right)$
<b>Gm</b>	$\frac{-g_m}{1 + (g_m + g_{mb})R_S}$	$g_m + g_{mb}$	$\frac{g_m}{1 + R_D/r_o}$

# Differential Amplifier

	Pseudo Diff Amp	Diff Pair (w/ ideal CS)	Diff Pair (w/ $R_{SS}$ )
$A_{vd}$	$-g_m R_D$	$-g_m R_D$	$-g_m R_D$
$A_{vCM}$	$-g_m R_D$	0	$\frac{-g_m R_D}{1 + 2(g_m + g_{mb})R_{SS}}$
$A_{vd}/A_{vCM}$	1	$\infty$	$2(g_m + g_{mb})R_{SS} \gg 1$

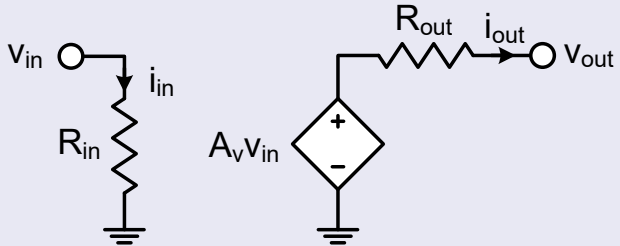
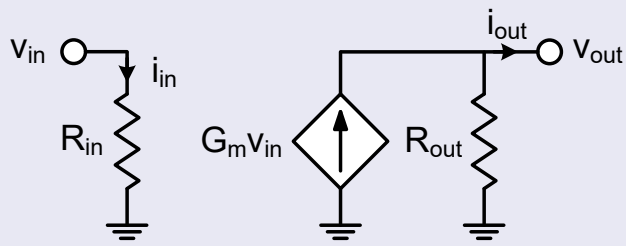
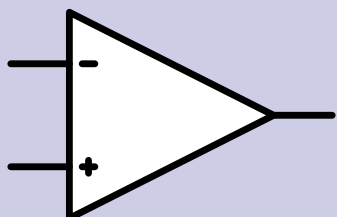
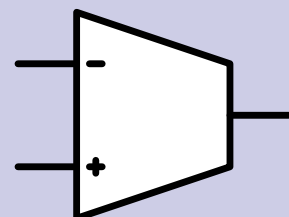
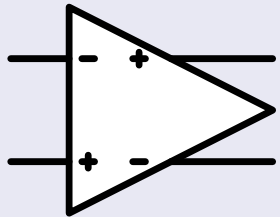
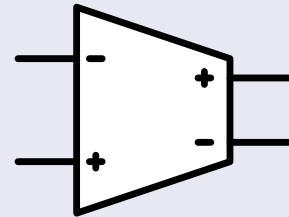
# What is an OTA / Op-Amp?

- ❑ An op-amp is simply a high gain differential amplifier
- ❑ The gain can be increased by using cascodes and multi-stage amplifiers



# Op-Amp vs OTA

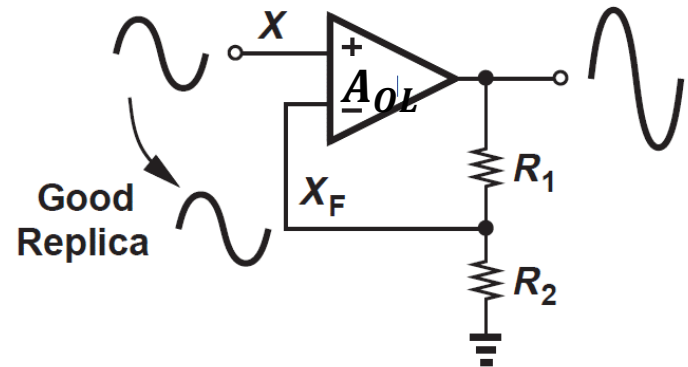
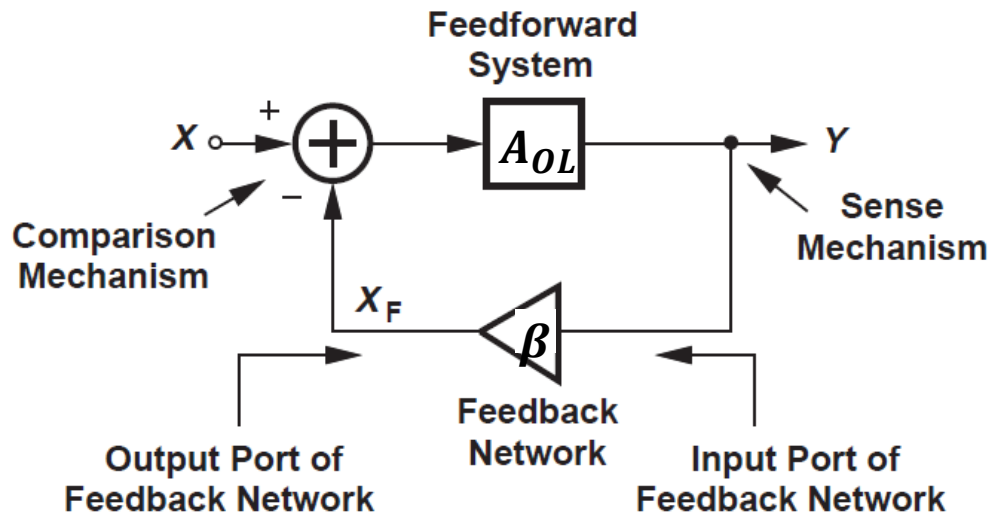
- ❑ An OTA is an op-amp without an output stage (buffer)
- ❑ Some designers just use op-amp name and symbol for both

	Op-amp	OTA
Rout	LOW	HIGH
Model		
Diff input, SE output		
Fully diff		

# Negative Feedback

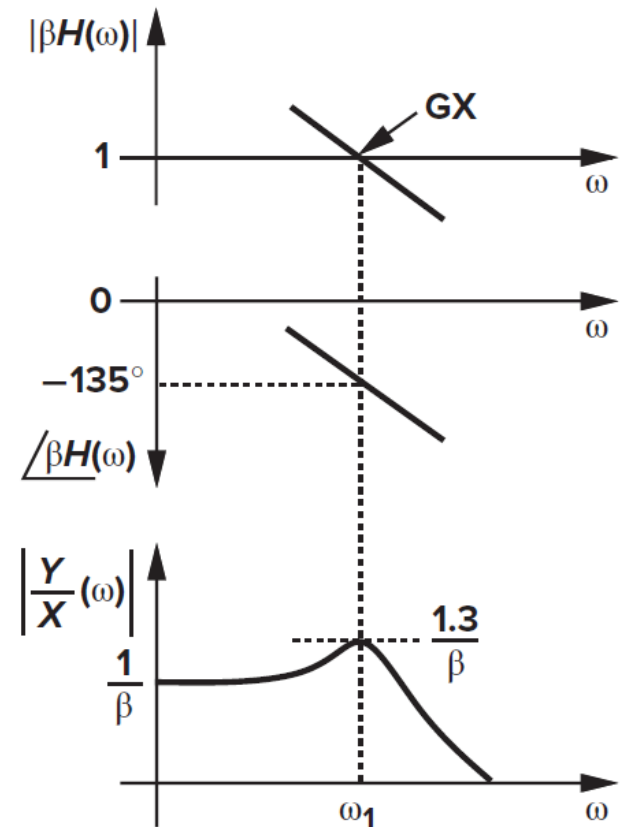
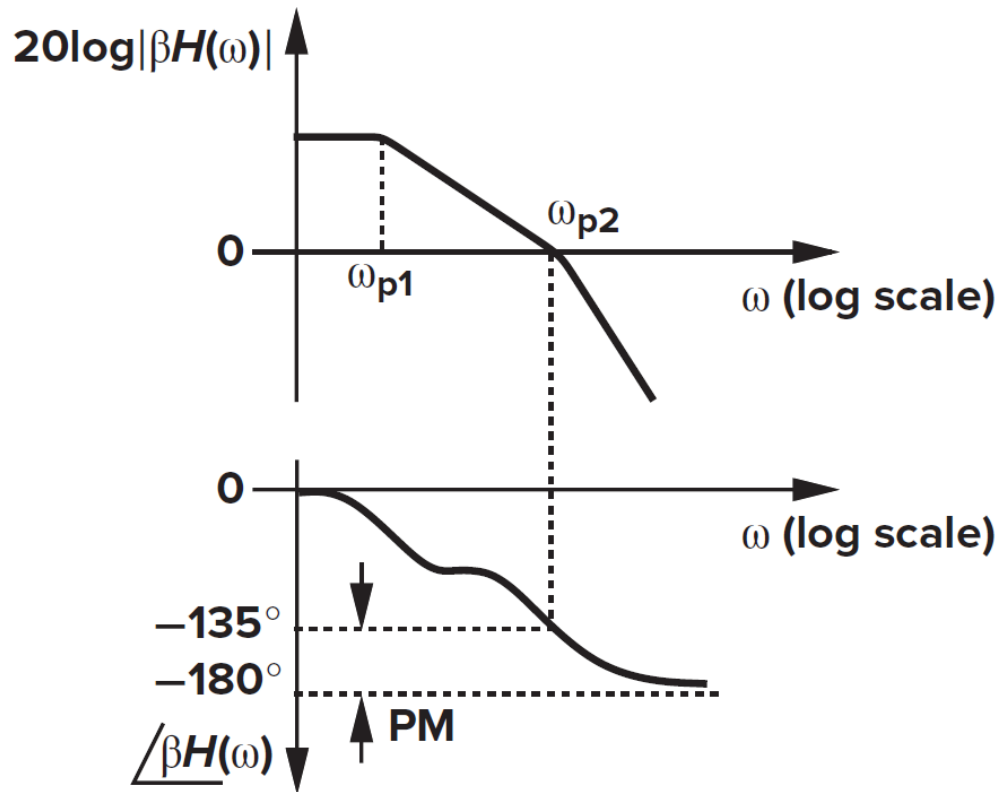
- ❑  $A_{OL}$  = Open loop (OL) gain  $\gg 1$
- ❑  $A_{CL} = \frac{Y}{X}$  = Closed loop (CL) gain
- ❑ Error signal =  $X - X_F$

$$Y = A_{OL}(X - X_F) = A_{OL}(X - \beta Y)$$
$$A_{CL} = \frac{Y}{X} = \frac{A_{OL}}{1 + \beta \cdot A_{OL}} \approx \frac{1}{\beta}$$



# Stability: Phase Margin

- ❑ If  $\omega_{p2} = \omega_u$ : PM =  $45^\circ \rightarrow$  typically inadequate (peaking/ringing)
- ❑ The ultimate  $\omega_u$  cannot exceed  $\omega_{p2} \rightarrow \omega_{p1} < \omega_u < \omega_{p2}$ 
  - For  $\omega < \omega_u$  the Bode plot is similar to a 1<sup>st</sup> order system



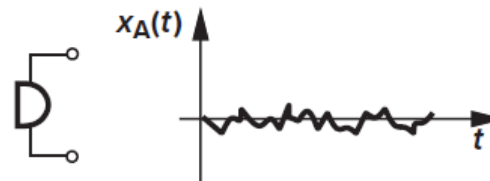
# In This Lecture: Part 1

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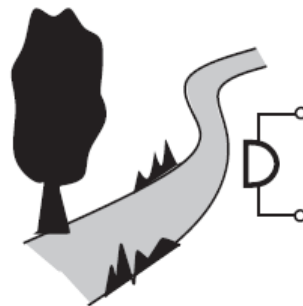
- ☐ Noise representation
- ☐ Noise power
- ☐ Signal-to-noise ratio (SNR)
- ☐ Resistor thermal noise
- ☐ MOSFET thermal and flicker noise
- ☐ Input-referred noise

# Noise in Time Domain

- ❑ Noise is a statistical random process
- ❑ We cannot predict its instantaneous value in advance
- ❑ But we can predict its average power
  - Noise of water flow is louder as we get closer to the river



(a)



(b)



# Noise Power

- Average power of a periodic signal (in Watts)

$$P_{av} = \frac{1}{T} \int_{-T/2}^{+T/2} \frac{v^2(t)}{R_L} dt$$

- Average power of a noise signal (in Watts)

$$P_{av} = \lim_{T \rightarrow \infty} \frac{1}{T} \int_{-T/2}^{+T/2} \frac{x^2(t)}{R_L} dt$$

- Drop  $R_L$  from the definition ( $P_{avg}$  now in  $V^2$ )

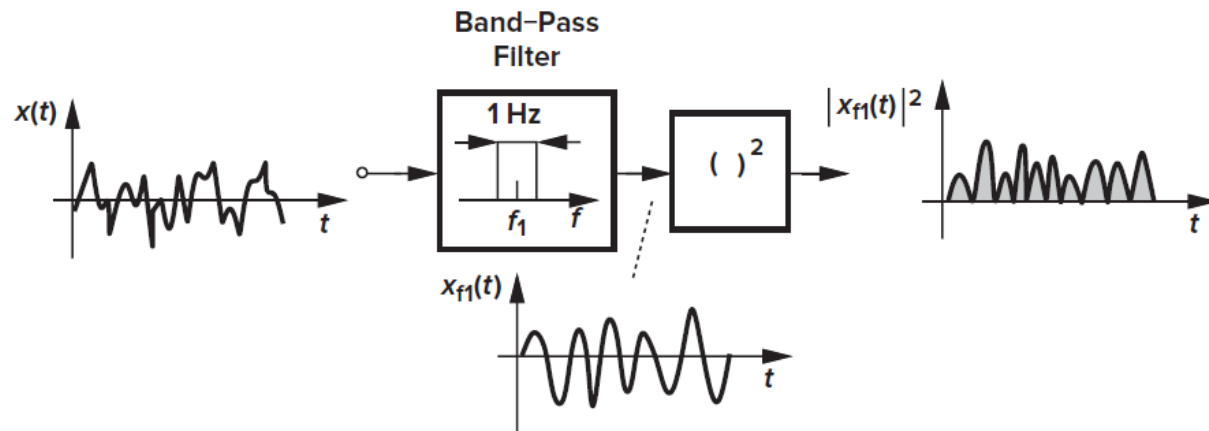
$$P_{av} = \lim_{T \rightarrow \infty} \frac{1}{T} \int_{-T/2}^{+T/2} x^2(t) dt$$

- RMS (root-mean-square) noise voltage

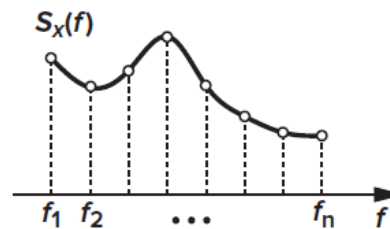
$$V_{nrms} = \sqrt{P_{avg}}$$

# Noise in Frequency Domain

- ❑ PSD: Power spectral density,  $S_x(f)$ , of a noise waveform  $x(t)$  is the average power carried by  $x(t)$  in a one-hertz bandwidth around  $f$ 
  - Measured in *Watts/Hz* or  $V^2/Hz$
- ❑ Voltage noise density:  $V_n(f) = \sqrt{S_x(f)} \rightarrow V/\sqrt{Hz}$



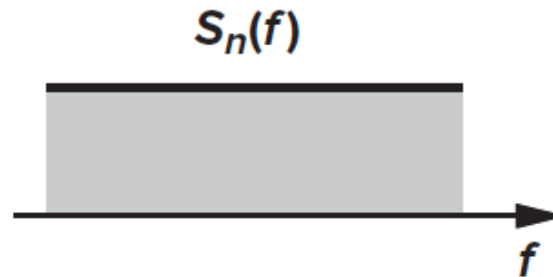
(a)



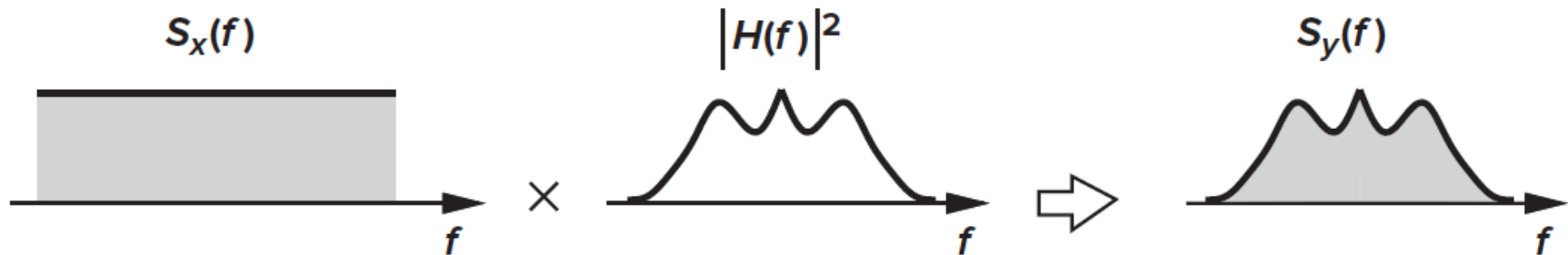
(b)

# White Noise and Noise Shaping

- ❑ White noise: PSD displays the same value at all frequencies (similar to white light)



- ❑ The noise spectrum is shaped by the system transfer function



- ❑ Average noise power is the area under the curve

$$P_{noise} = \int_{-\infty}^{+\infty} S_{noise}(f) df$$

# Example

□  $S_{noise}(f) = 5 \times 10^{-16} \text{V}^2/\text{Hz}$  and  $BW = 1\text{MHz}$

$$\begin{aligned} P_{noise} &= \int_0^{1 \text{ MHz}} S_{noise}(f) df \\ &= 5 \times 10^{-10} \text{ V}^2 \end{aligned}$$

$$V_{nrms} = \sqrt{P_{noise}} = 22.4 \mu\text{V}_{rms}$$

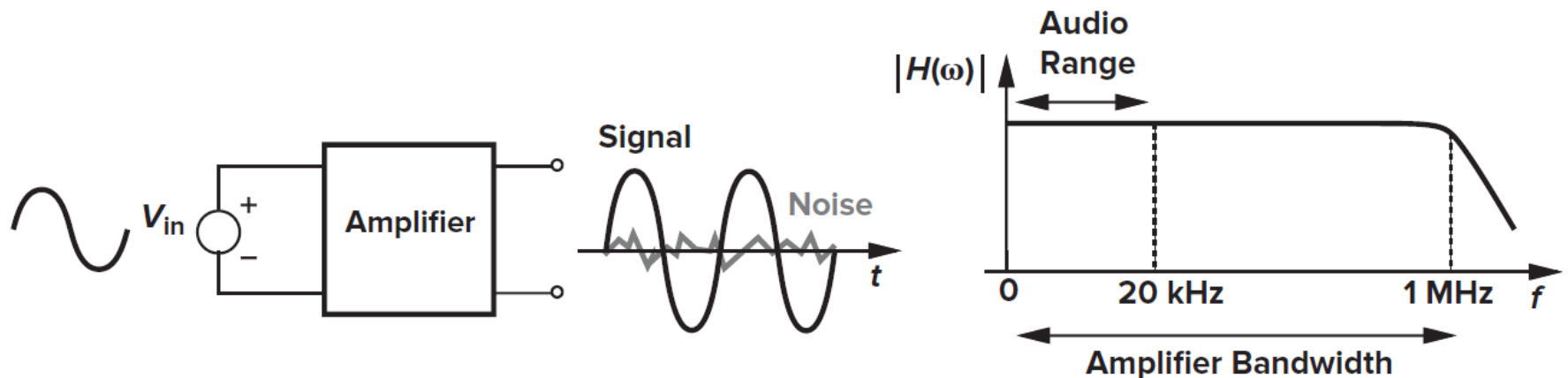
# Signal-to-Noise Ratio (SNR)

$$SNR = \frac{P_{signal}}{P_{noise}} = \frac{V_{sigrms}^2}{V_{nrms}^2}$$

$$P_{noise} = \int_{-\infty}^{+\infty} S_{noise}(f) df$$

$$V_{nrms} = \sqrt{P_{noise}}$$

❑ Wide BW is not good BW → The BW should just fit the signal



# Multiple Noise Sources

- ❑ Noise adds in time domain

$$v_{no}(t) = v_{n1}(t) + v_{n2}(t)$$

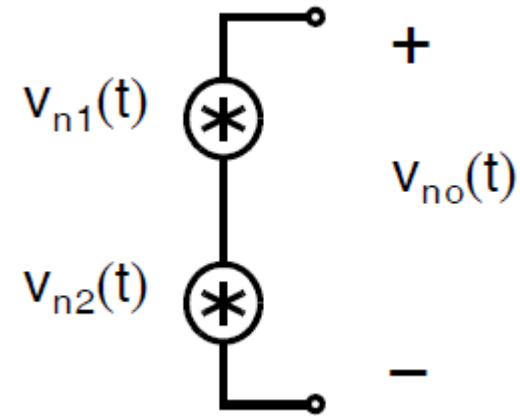
- ❑ But RMS values do not simply add

$$V_{no(rms)}^2 = \frac{1}{T} \int_0^T [v_{n1}(t) + v_{n2}(t)]^2 dt$$

$$V_{no(rms)}^2 = V_{n1(rms)}^2 + V_{n2(rms)}^2 + \frac{2}{T} \int_0^T v_{n1}(t) v_{n2}(t) dt$$

- ❑ Correlation coefficient ( $-1 \leq C \leq 1$ )

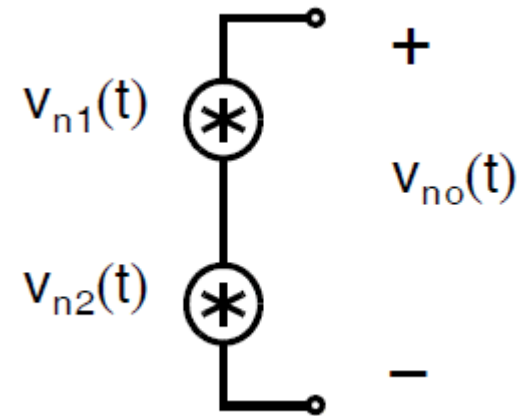
$$C \equiv \frac{\frac{1}{T} \int_0^T v_{n1}(t) v_{n2}(t) dt}{V_{n1(rms)} V_{n2(rms)}}$$



# Multiple Noise Sources

- Correlation coefficient ( $-1 \leq C \leq 1$ )

$$C \equiv \frac{\frac{1}{T} \int_0^T v_{n1}(t) v_{n2}(t) dt}{V_{n1(\text{rms})} V_{n2(\text{rms})}}$$



- Total RMS noise voltage

$$V_{no(\text{rms})}^2 = V_{n1(\text{rms})}^2 + V_{n2(\text{rms})}^2 + 2CV_{n1(\text{rms})}V_{n2(\text{rms})}$$

- Usually we have uncorrelated noise sources ( $C = 0$ )

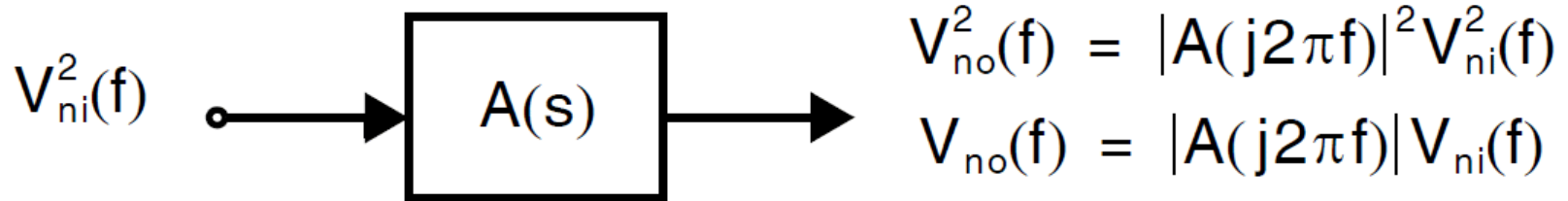
$$V_{no(\text{rms})}^2 = V_{n1(\text{rms})}^2 + V_{n2(\text{rms})}^2$$

- The largest noise contributor dominates:  $3^2 + 1^2 \approx 3^2$

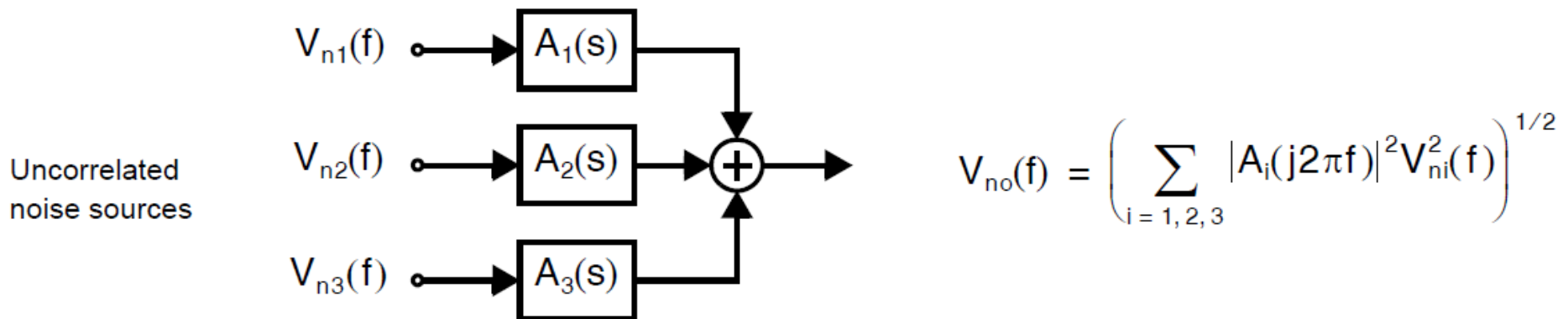
- Note that for the other extreme case of fully correlated signals

$$V_{no(\text{rms})}^2 = [V_{n1(\text{rms})} \pm V_{n2(\text{rms})}]^2$$

# Multiple Noise Sources



- Uncorrelated noise signals remain uncorrelated, even when filtered by a circuit's magnitude response

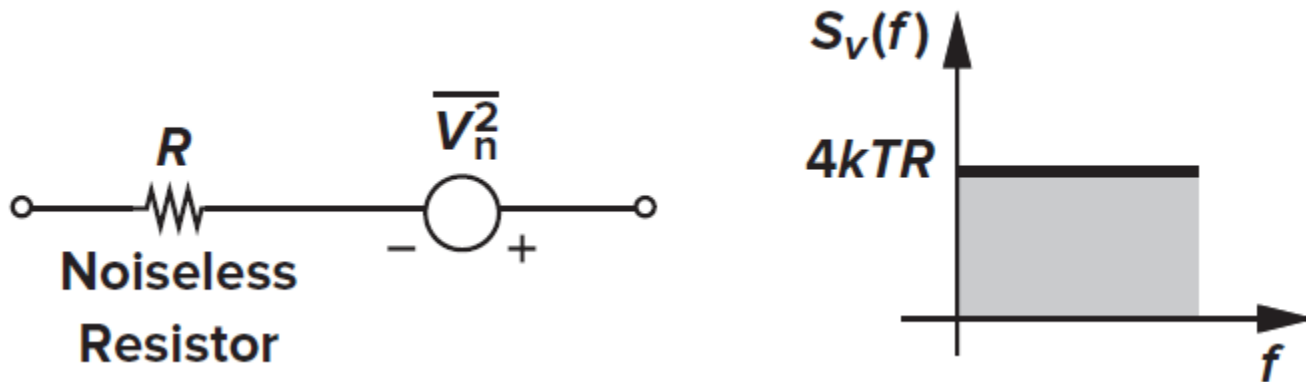




# Resistor Thermal Noise

- ❑ The random motion of electrons in a conductor introduces fluctuations in the voltage measured across the conductor, even if the average current is zero

$$V_n^2(f) = S_v(f) = 4kTR$$

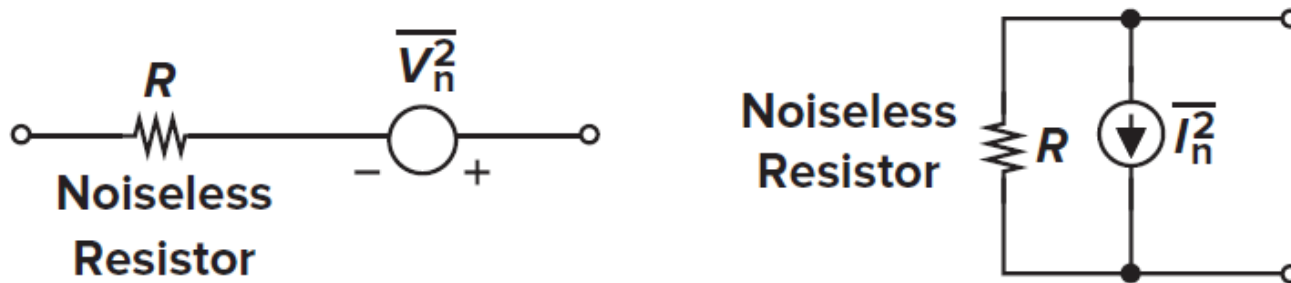


- ❑ A number to remember
  - For  $R = 1k\Omega \quad \rightarrow \quad V_n(f) \approx 4nV/\sqrt{Hz}$

# Resistor Thermal Noise

- ❑ The random motion of electrons in a conductor introduces fluctuations in the voltage measured across the conductor, even if the average current is zero

$$I_n^2(f) = \frac{V_n^2(f)}{R^2} = \frac{4kT}{R}$$

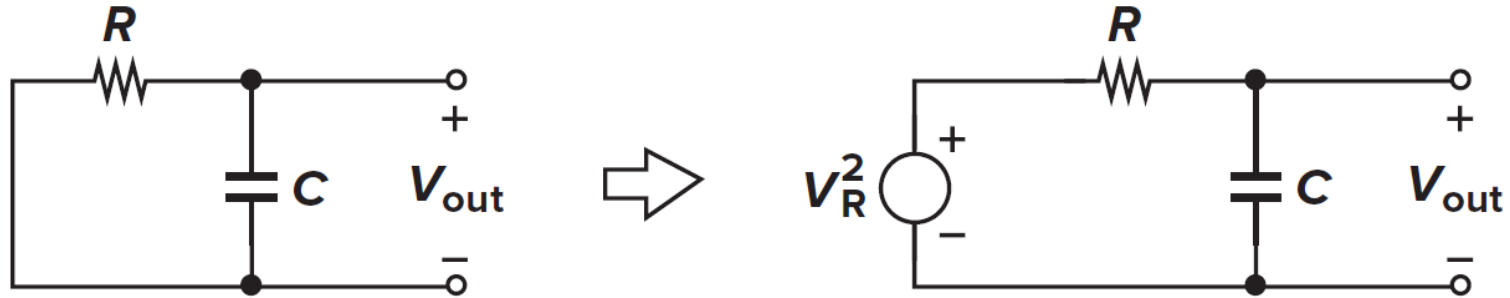


- ❑ A number to remember

- For  $R = 1k\Omega \rightarrow I_n(f) \approx 4pA/\sqrt{Hz}$

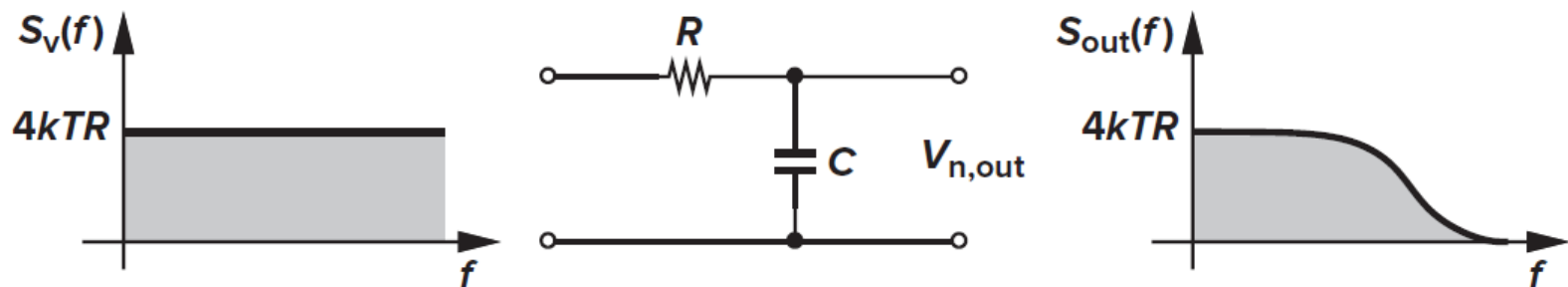
# Noise in RC Circuit

- Resistors never exist alone → The BW is always limited by a cap



$$S_{out}(f) = S_v(f) \left| \frac{V_{out}(\omega)}{V_R(\omega)} \right|^2$$

$$V_{nrms}^2 = P_{nout} = \int_{-\infty}^{\infty} S_{out}(f) df = \frac{kT}{C}$$



# Noise in RC Circuit

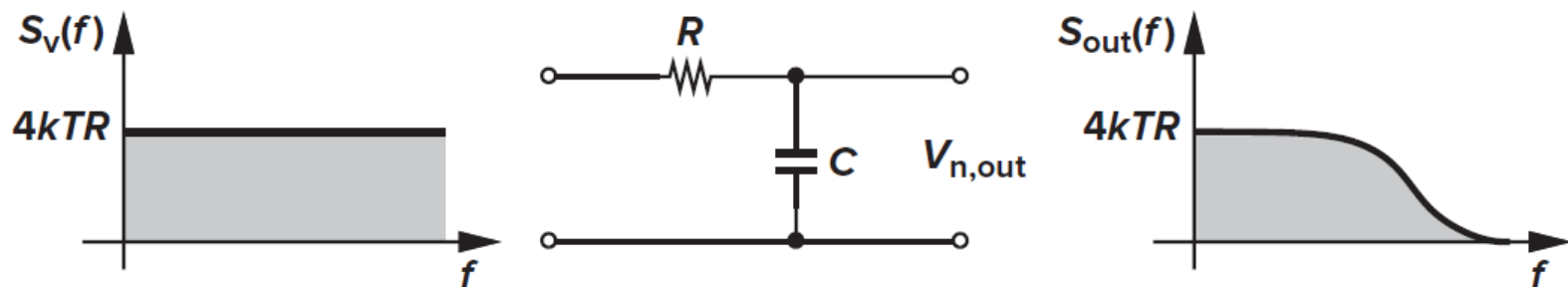
- ❑ Resistors never exist alone → The BW is always limited by a cap

$$V_{nrms}^2 = \frac{kT}{C}$$

- ❑ RMS noise is independent of  $R$ !!!

- ❑ A number to remember

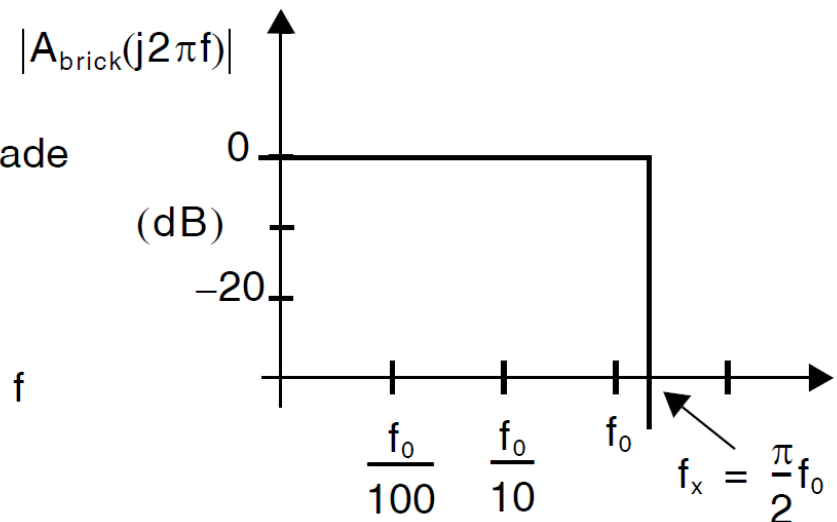
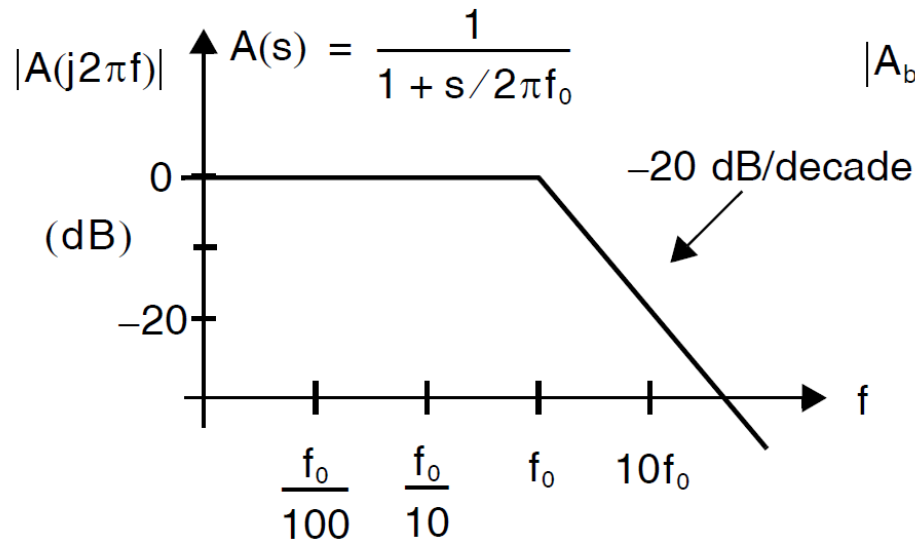
- For  $C = 1pF$  →  $V_{nrms} \approx 64\mu V_{rms}$



# Equivalent Noise Bandwidth

$$V_{nrms}^2 = P_{nout} = \int_{-\infty}^{\infty} S_{out}(f) df = S_{out}(f) \times B_N$$

$$S_{out}(f) \times B_N = 4kTR \times B_N = \frac{kT}{C} \rightarrow B_N = \frac{1}{4RC} = \frac{\pi}{2} f_p$$



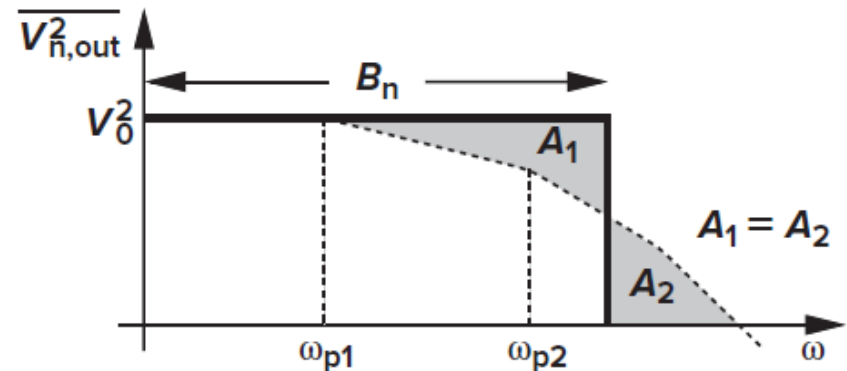
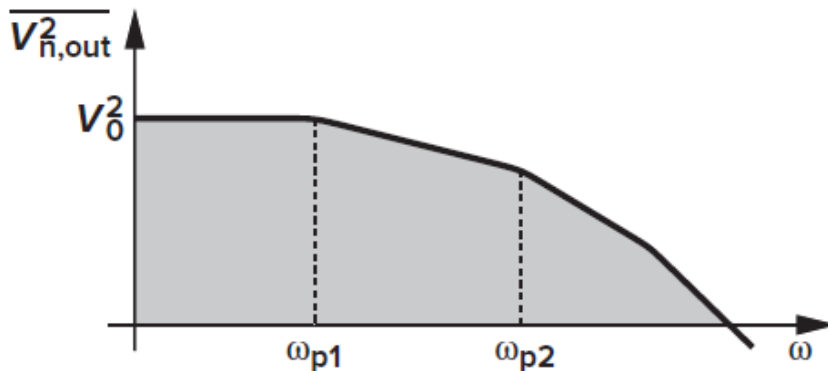
# Equivalent Noise Bandwidth

$$V_{nrms}^2 = P_{nout} = \int_{-\infty}^{\infty} S_{out}(f) df = S_{out}(f) \times B_N$$

$$S_{out}(f) \times B_N = 4kTR \times B_N = \frac{kT}{C} \rightarrow B_N = \frac{1}{4RC} = \frac{\pi}{2} f_p$$

□ In general

$$B_N = \frac{\int_{-\infty}^{\infty} S_{out}(f) df}{S_{out}(f)}$$



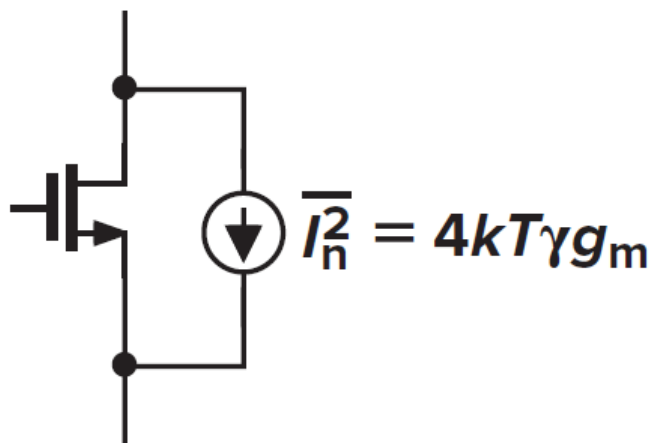
# MOSFET Channel Thermal Noise

- ❑ MOS transistors also exhibit thermal noise
- ❑ The most significant source is the noise generated in the channel
- ❑ For long-channel MOS devices

$$I_n^2(f) = 4kT\gamma g_m$$

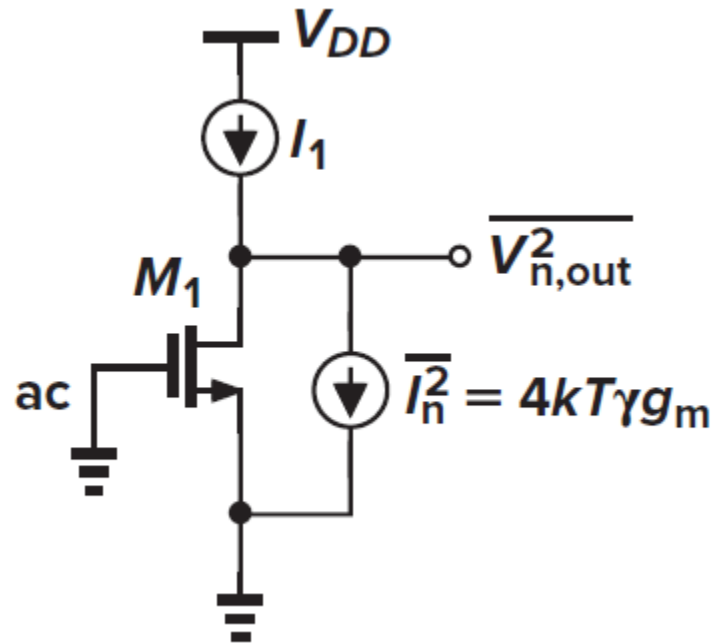
- Similar to a resistor with  $R = \frac{1}{\gamma g_m}$

- ❑  $\gamma = \frac{2}{3}$  for long channel MOS, but close to 1 for short channel MOS



# MOSFET Channel Max Voltage Noise

$$\begin{aligned}\overline{V_n^2} &= \overline{I_n^2} r_O^2 \\ &= (4kT\gamma g_m) r_O^2\end{aligned}$$



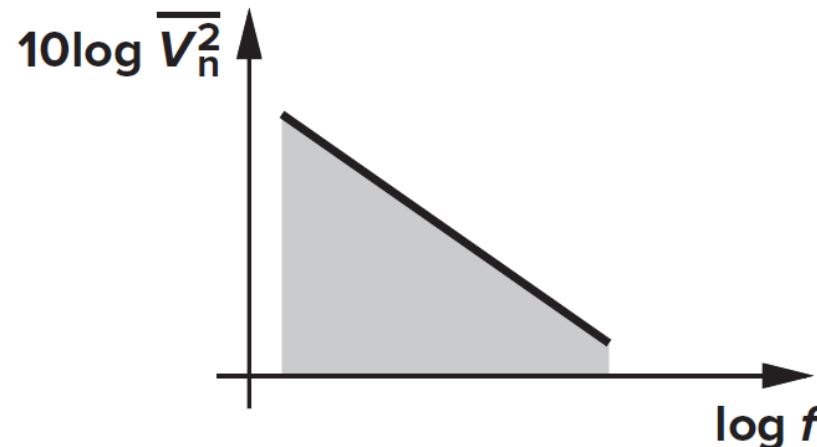


# MOSFET Flicker Noise

- ❑ Mainly due to dangling bonds at the interface between the gate oxide and the silicon substrate

$$V_n^2(f) = \frac{K}{C_{ox}WL} \frac{1}{f}$$

- ❑  $K$ : Flicker noise coefficient
- ❑ A.k.a.  $1/f$  Noise
- ❑ Can be reduced by increasing device area

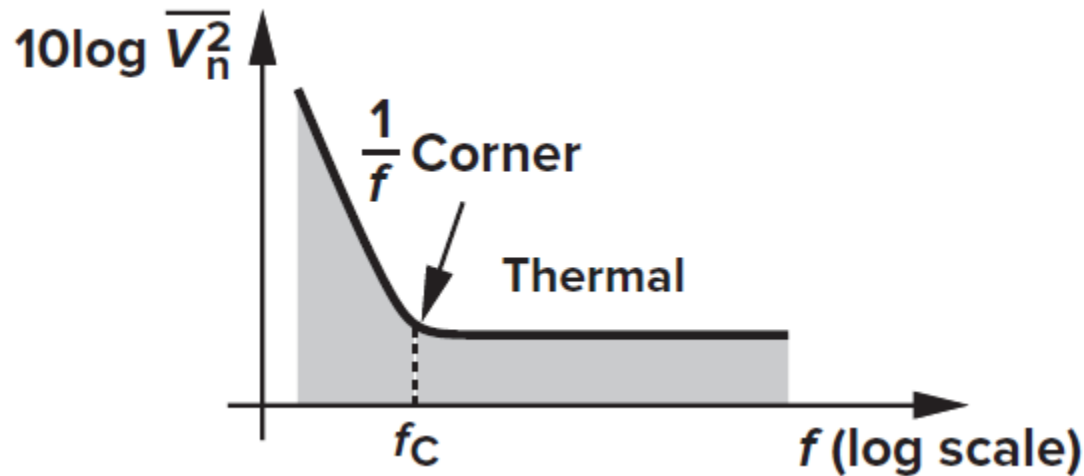


# Flicker Noise Corner

- ❑ Serves as a measure of what part of the band is mostly corrupted by flicker noise

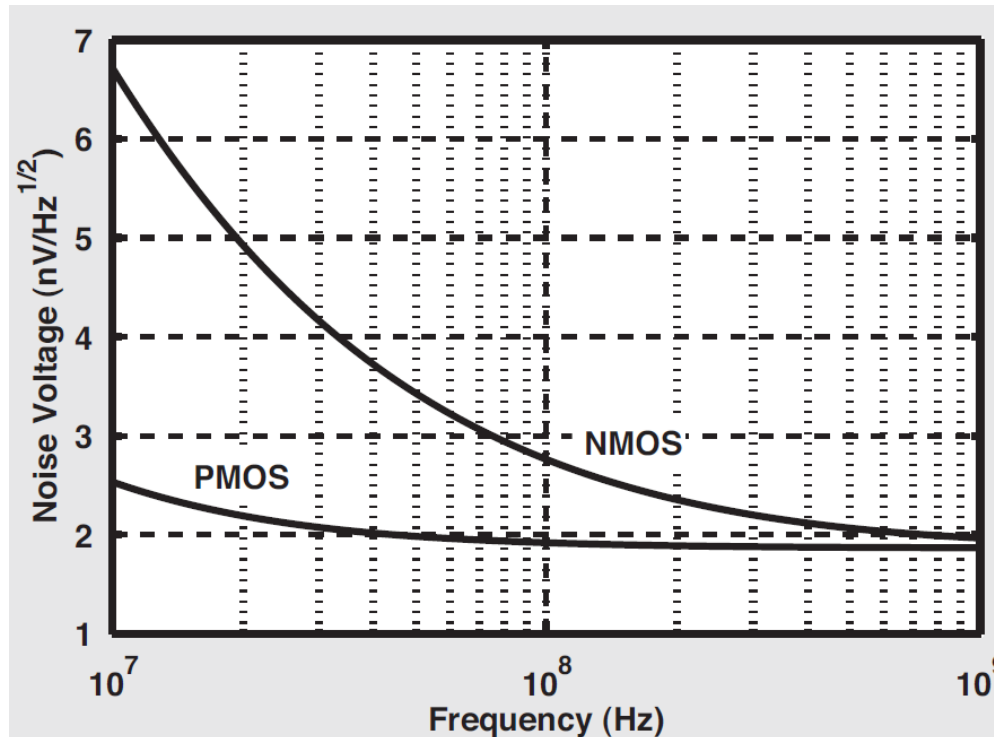
$$4kT\gamma g_m = \frac{K}{C_{ox}WL} \cdot \frac{1}{f_C} \cdot g_m^2$$

$$f_C = \frac{K}{\gamma C_{ox}WL} g_m \frac{1}{4kT}$$

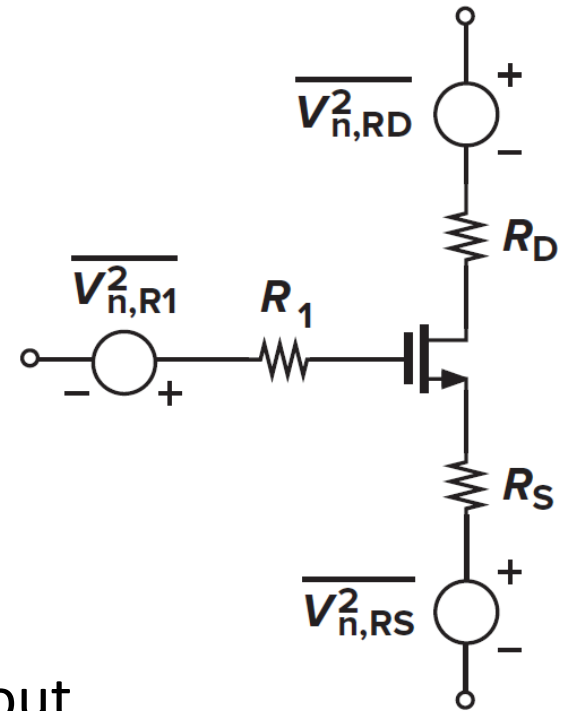
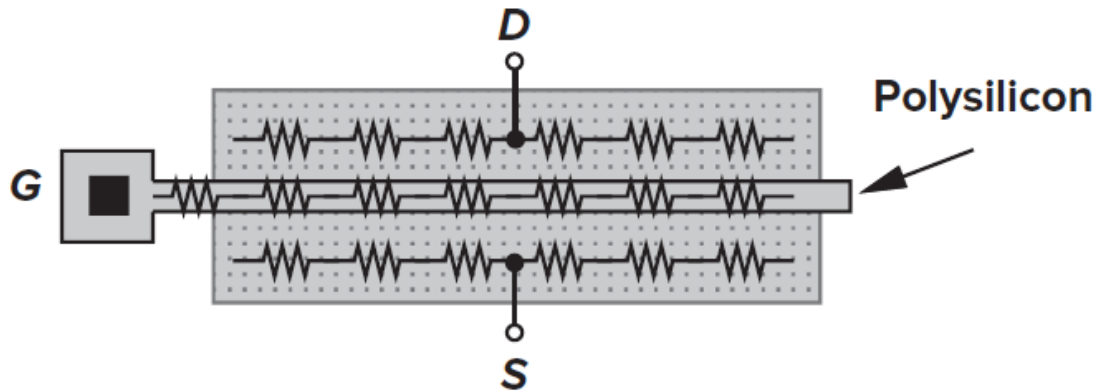


# Short Channel MOS Flicker Noise

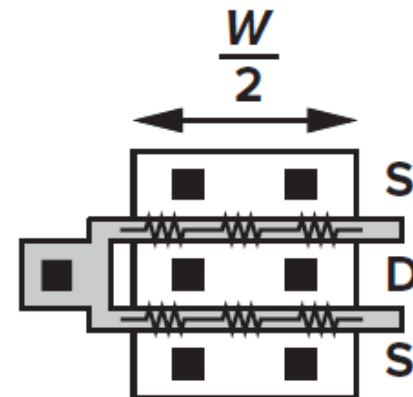
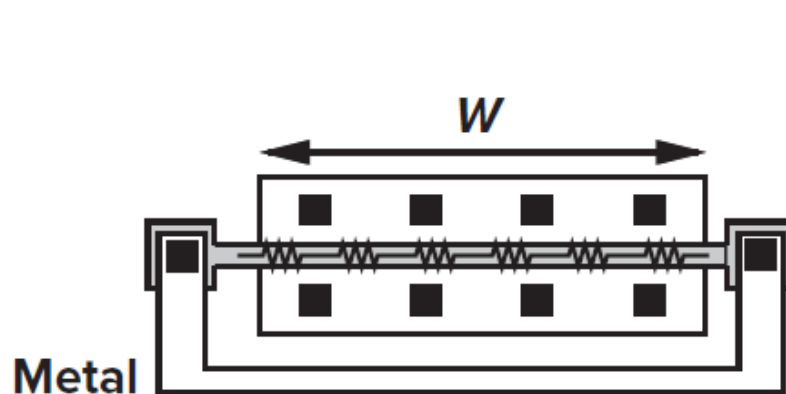
- ❑ PMOS and NMOS devices with  $W/L = 5 \mu\text{m}/40 \text{ nm}$  and  $I_D = 250 \mu\text{A}$
- ❑ PMOS devices exhibit significantly less noise
- ❑ NMOS flicker noise corner is as high as several hundred megahertz
- ❑ For low flicker noise, gate area must be increased substantially



# MOSFET Terminal Resistances Noise



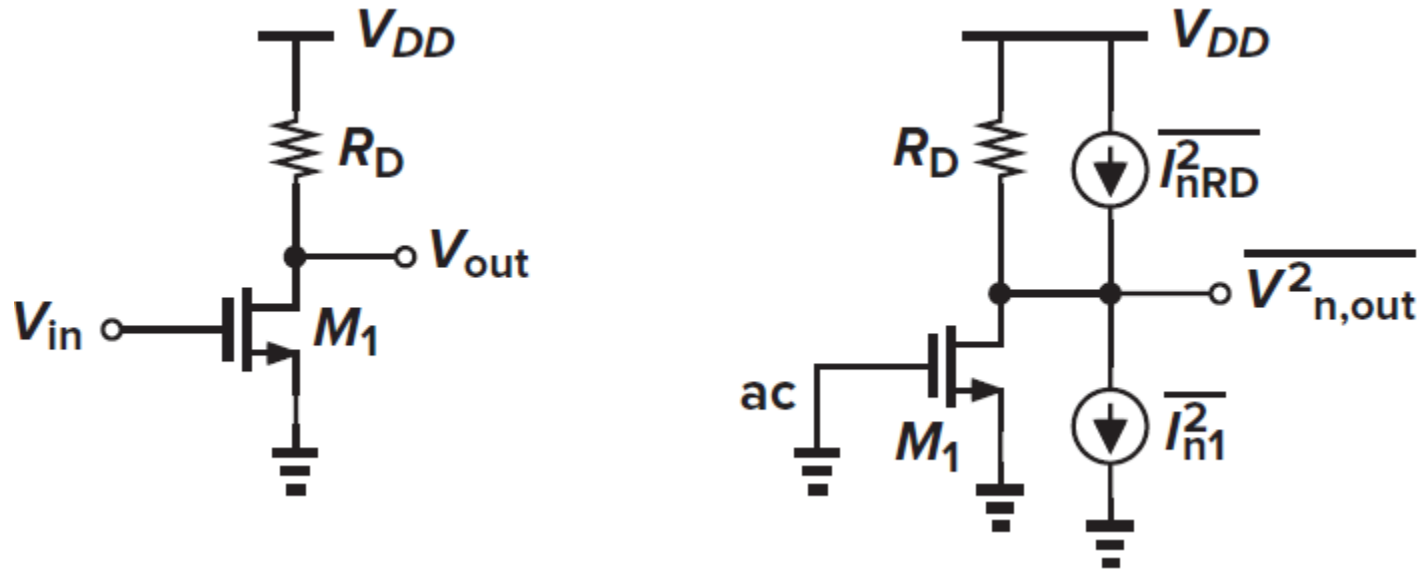
❑ Terminal resistances reduced by proper layout



# Noise Analysis Procedure

- ❑ Identify the sources of noise (e.g., resistors and transistors) and write down the noise density of each
- ❑ Set the input signal to zero
- ❑ Find the transfer function from each noise source to the output (as if the source were a deterministic signal)
- ❑ Utilize the theorem  $S_Y(f) = S_X(f)|H(f)|^2$  to calculate the output noise spectrum contributed by each noise source
- ❑ Add all of the output spectra, paying attention to correlated and uncorrelated sources
- ❑ This procedure gives the output noise spectrum, which must then be integrated to yield the total output noise

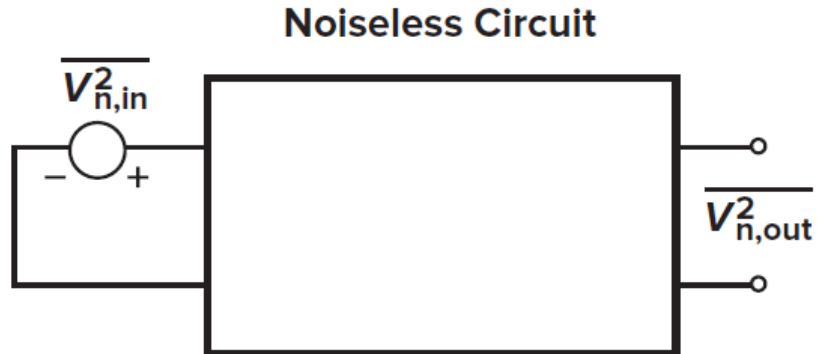
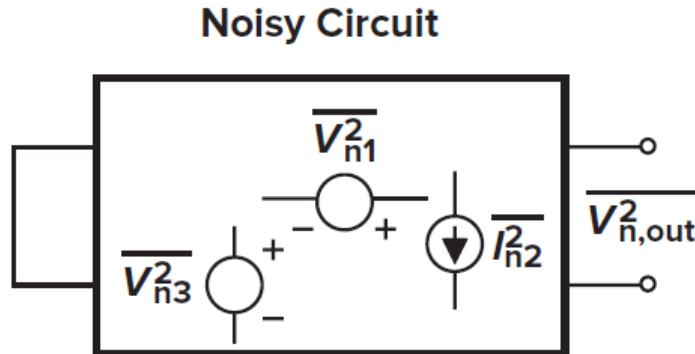
# Ex: Output Noise in CS Amplifier



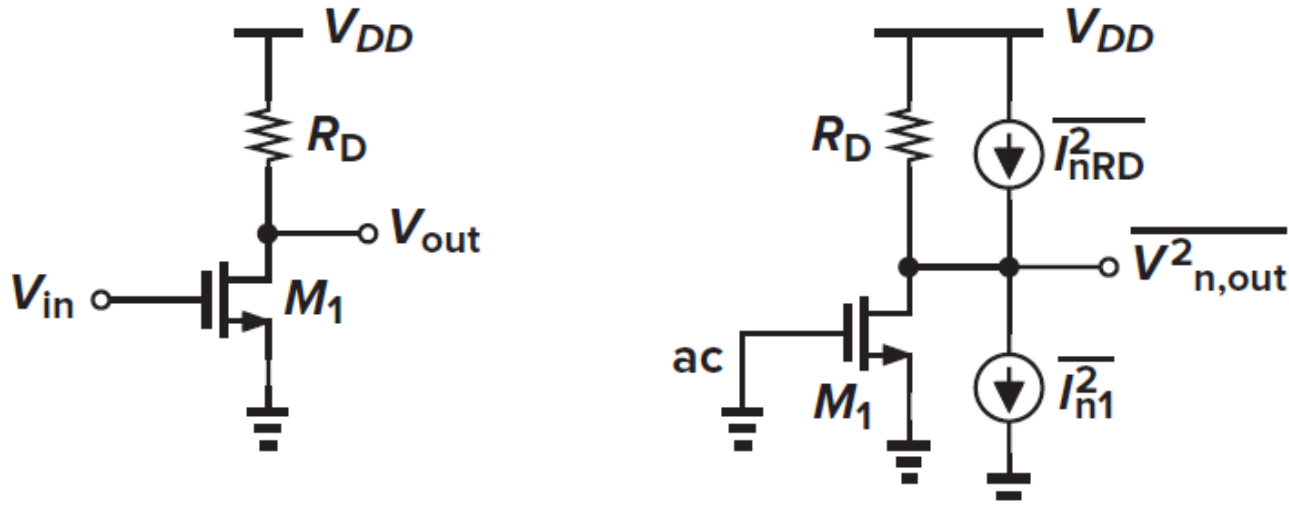
$$\overline{V_{n,out}^2} = \left( 4kT\gamma g_m + \frac{K}{C_{ox}WL} \cdot \frac{1}{f} \cdot g_m^2 + \frac{4kT}{R_D} \right) R_D^2$$

# Input-Referred Noise

- ❑ The output-referred noise does not allow a fair comparison of the performance of different circuits because it depends on the gain
  - The signal is multiplied by the gain as well!
  - The noise should be referred to the input



# Ex: Input-Referred Noise in CS Amplifier

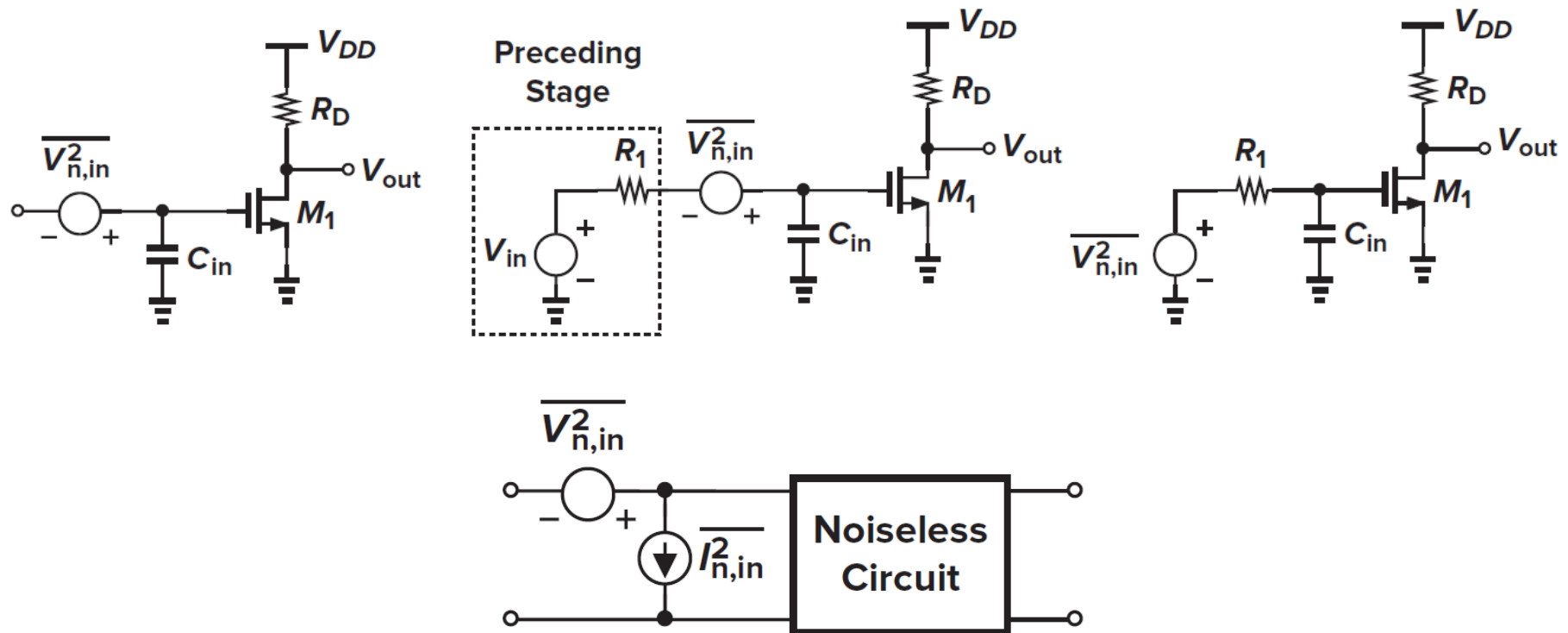


$$\begin{aligned}\overline{V_{n,in}^2} &= \frac{\overline{V_{n,out}^2}}{A_v^2} \\ &= \left( 4kT\gamma g_m + \frac{K}{C_{ox}WL} \cdot \frac{1}{f} \cdot g_m^2 + \frac{4kT}{R_D} \right) R_D^2 \frac{1}{g_m^2 R_D^2} \\ &= 4kT \frac{\gamma}{g_m} + \frac{K}{C_{ox}WL} \cdot \frac{1}{f} + \frac{4kT}{g_m^2 R_D}\end{aligned}$$



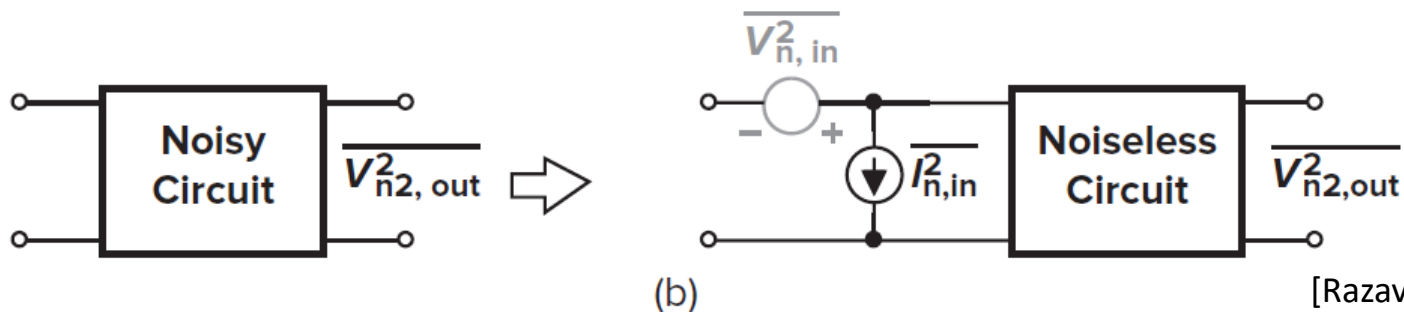
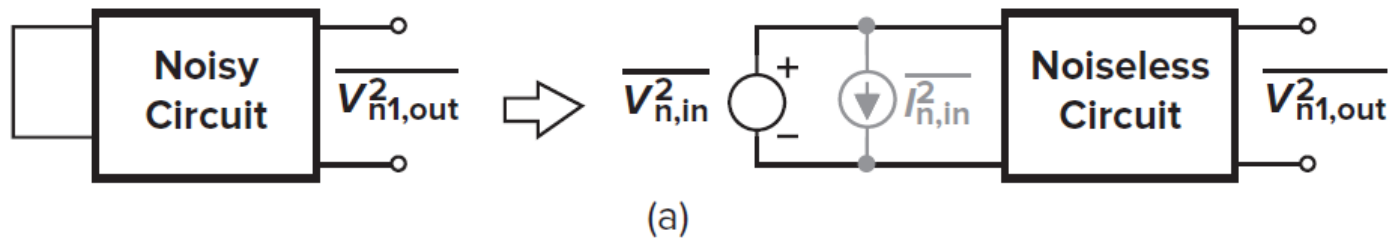
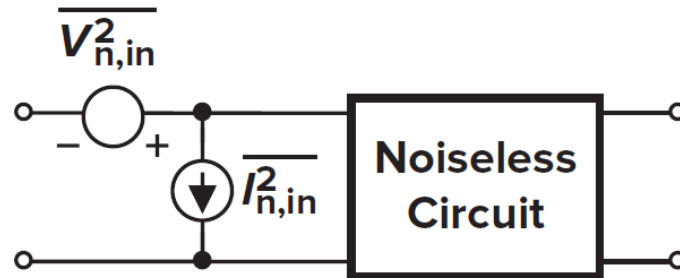
# Input-Referred Noise

- ❑ The noise due to  $M_1$  channel should be independent of the source impedance  $R_1$ , but if  $R_1 \rightarrow \infty$  output noise is zero!!!
- ❑ Modeling the noise by  $V_{n,in}^2$  alone is not sufficient
- ❑ A complete model can be provided by  $V_{n,in}^2$  and  $I_{n,in}^2$



# Input-Referred Noise

- ❑ Zero source impedance  $\rightarrow$  Calculate  $V_{n,in}^2$
- ❑ Infinite source impedance  $\rightarrow$  Calculate  $I_{n,in}^2$



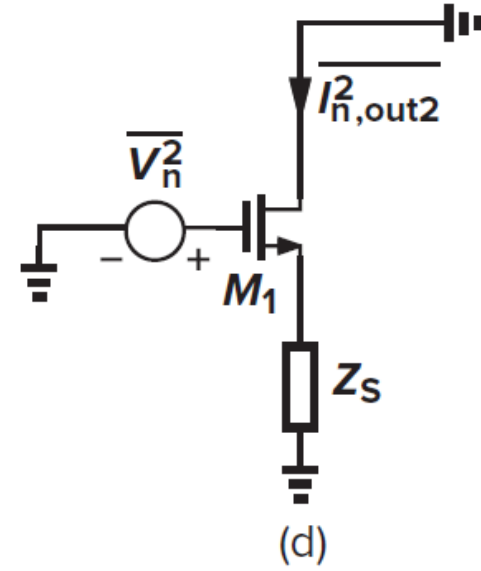
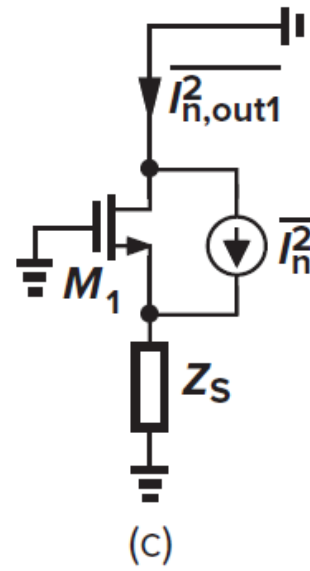
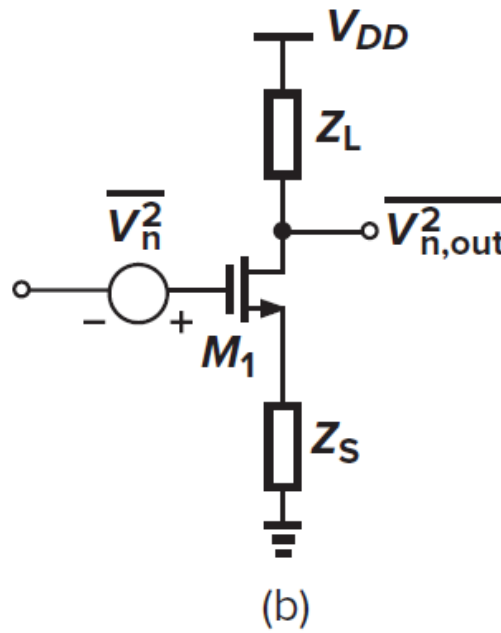
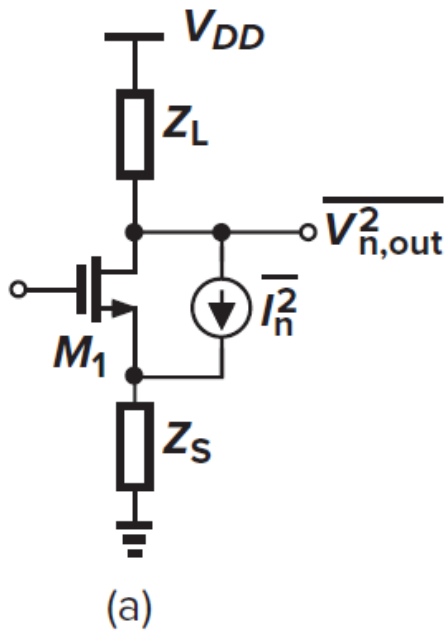
# In This Lecture: Part 2

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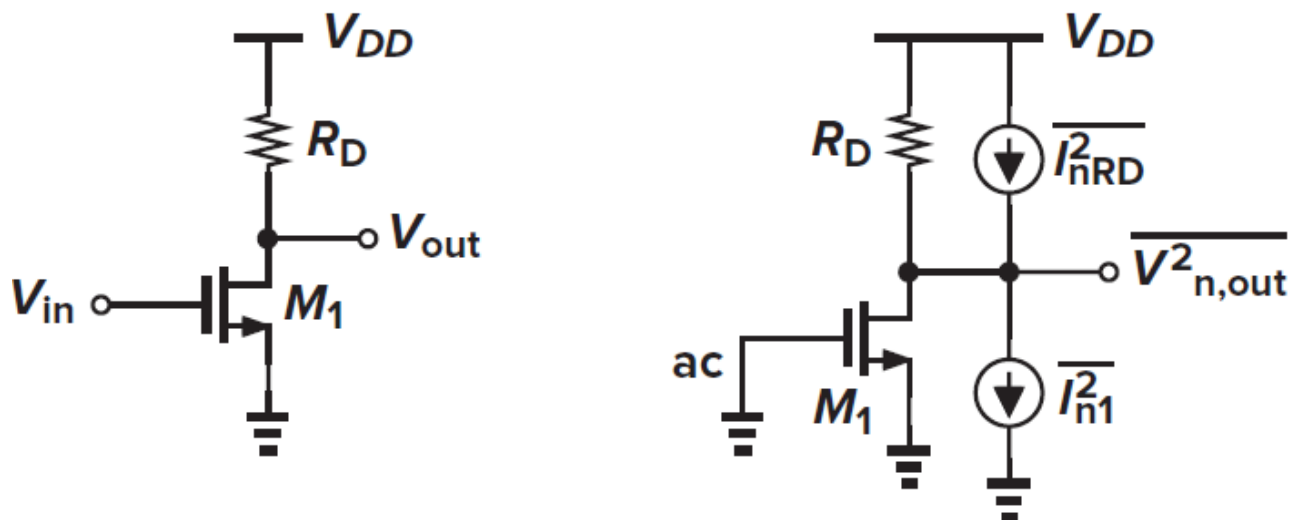
- ❑ Noise in Amplifiers
  - Common source amplifier
  - Common gate amplifier
  - Common drain amplifier
  - Cascode amplifier
  - Differential amplifier
  - Common OTA topologies

# Useful Lemma

- You can show that (a) and (b) are equivalent if  $I_n^2 = g_m^2 V_n^2$ . Neglect body effect and CLM (the result is valid even if we consider them).
- Hint: Show that the short circuit output current is the same in (c) and (d).



# Common Source Amplifier



$$\overline{V_{n,in}^2} = 4kT \left( \frac{\gamma}{g_m} + \frac{1}{g_m^2 R_D} \right) + \frac{K}{C_{ox} W L} \frac{1}{f}$$

- If we focus on thermal noise and substitute for  $g_m$

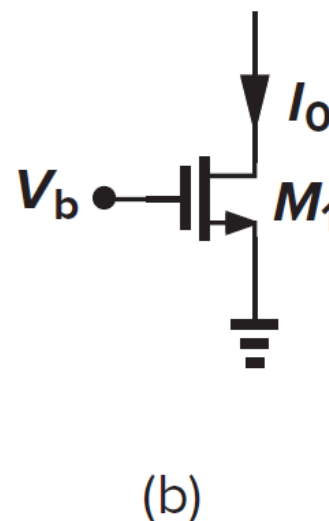
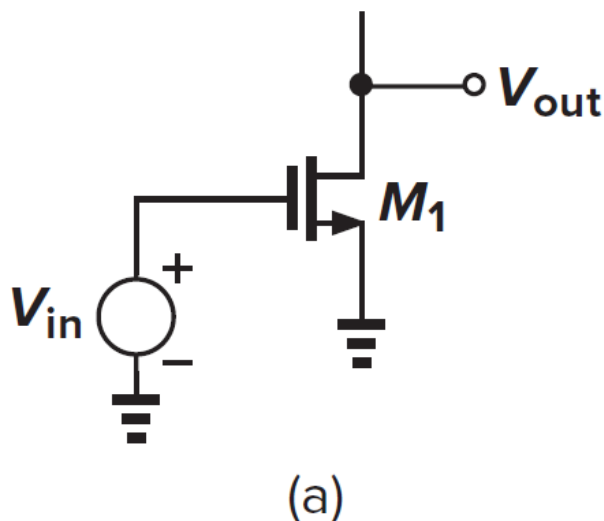
$$\overline{V_{n,in}^2} = 4kT \left[ \frac{\gamma(V_{GS} - V_{TH})}{2I_D} + \frac{(V_{GS} - V_{TH})^2}{4I_D \cdot I_D R_D} \right]$$

- Tradeoff between noise and power consumption

# Common Source Amplifier

- From noise perspective, do we want small or large  $g_m$ ?
- Amplifier/transconductor (a)  $\rightarrow$  Maximize  $g_m$
  - Constant current source (b)  $\rightarrow$  Minimize  $g_m$

$$\overline{V_{n,in}^2} = 4kT \left( \frac{\gamma}{g_m} + \frac{1}{g_m^2 R_D} \right) + \frac{K}{C_{ox} W L} \frac{1}{f}$$



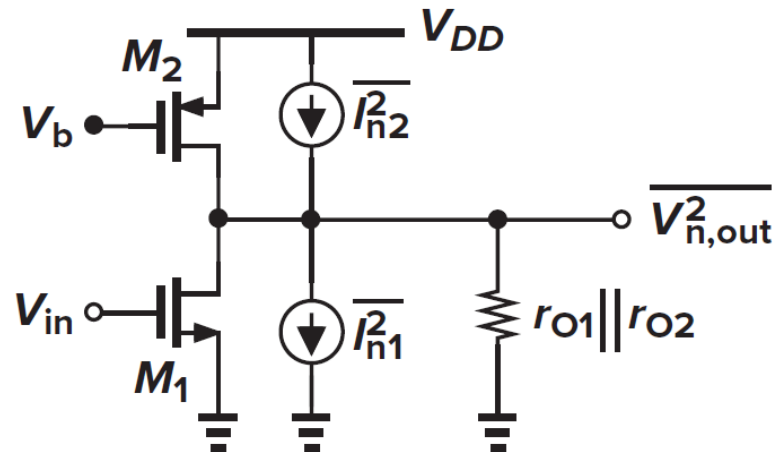
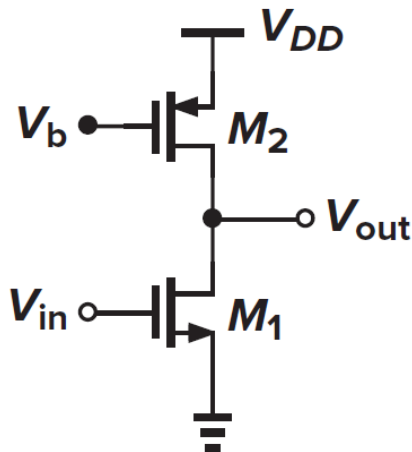
# Common Source Amplifier

- Maximize  $g_{m1}$  (transconductor) and minimize  $g_{m2}$  (current source)

$$\overline{V_{n,out}^2} = 4kT(\gamma g_{m1} + \gamma g_{m2})(r_{O1} \parallel r_{O2})^2$$

$$\overline{V_{n,in}^2} = 4kT(\gamma g_{m1} + \gamma g_{m2}) \frac{1}{g_{m1}^2}$$

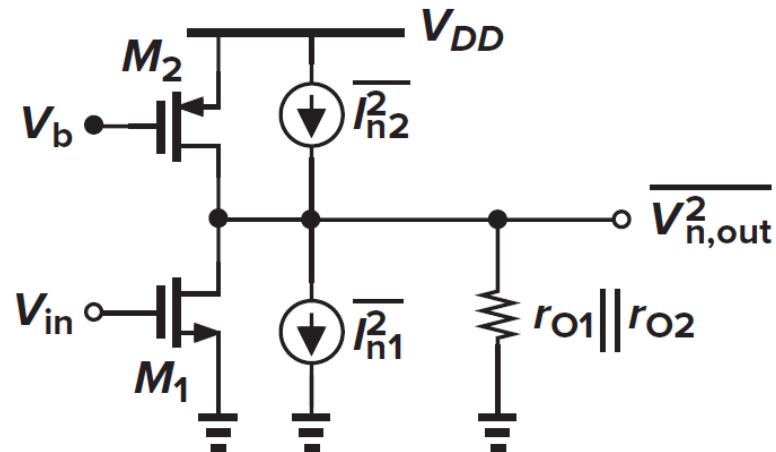
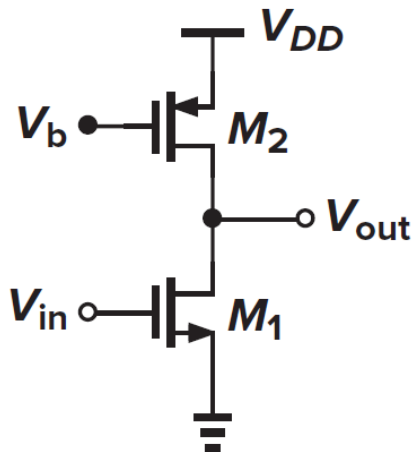
$$= 4kT\gamma \left( \frac{1}{g_{m1}} + \frac{g_{m2}}{g_{m1}^2} \right)$$



# Common Source Amplifier

- Assume a load capacitance  $C_L$

$$\begin{aligned}
 V_{n,out,rms}^2 &= V_{n,out}^2 \times B_N \\
 &= 4kT\gamma \left( \frac{1}{g_{m1}} + \frac{g_{m2}}{g_{m1}^2} \right) \times g_{m1}^2 (r_{o1} // r_{o2})^2 \times \frac{1}{4(r_{o1} // r_{o2})C_L} \\
 &= (g_{m1} + g_{m2})(r_{o1} // r_{o2}) \frac{kT\gamma}{C_L}
 \end{aligned}$$



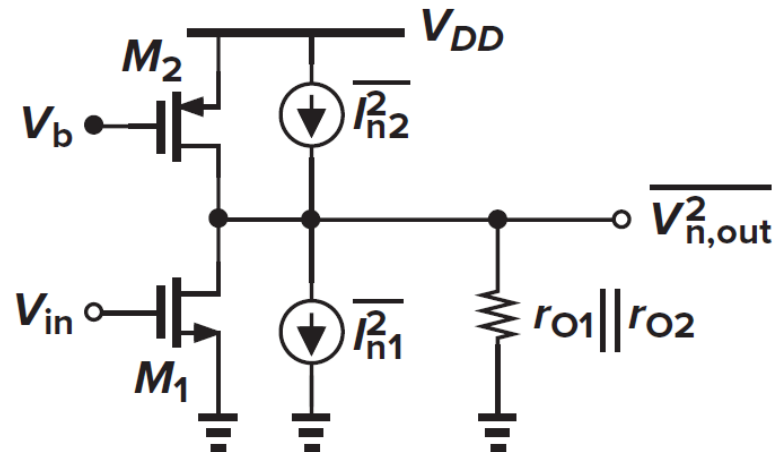
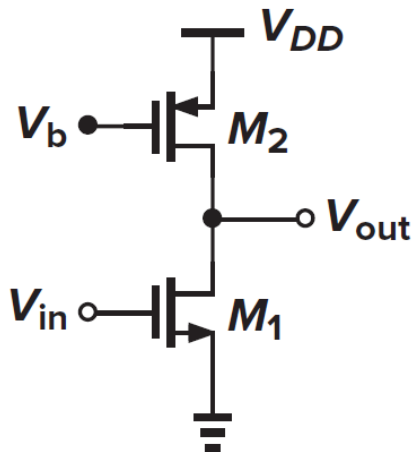


# Common Source Amplifier

- Assume a sinusoidal input with amplitude =  $V_m$

$$\text{SNR}_{out} = \left[ \frac{g_{m1}(r_{O1} \parallel r_{O2}) V_m}{\sqrt{2}} \right]^2 \cdot \frac{1}{\gamma(g_{m1} + g_{m2})(r_{O1} \parallel r_{O2})(kT/C_L)}$$

$$= \frac{C_L}{2\gamma kT} \cdot \frac{g_{m1}^2(r_{O1} \parallel r_{O2})}{g_{m1} + g_{m2}} V_m^2$$



# Common Gate and Common Drain

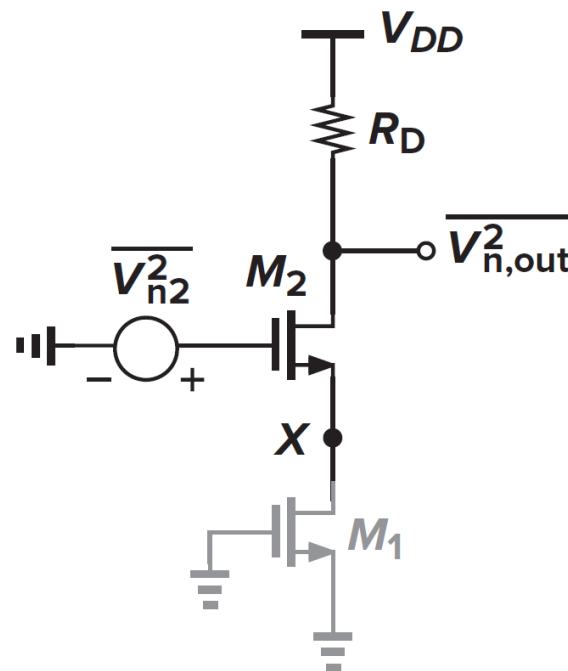
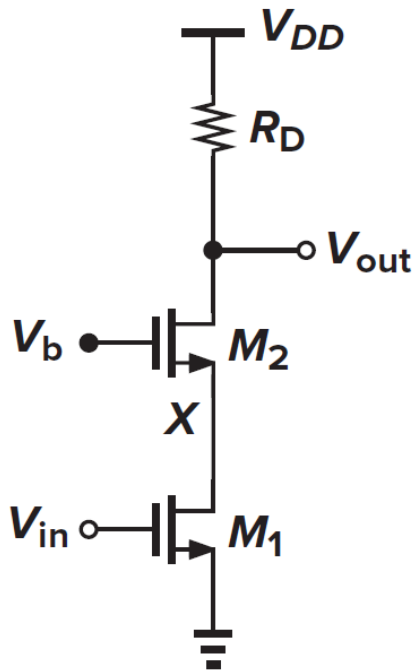
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- ❑ Read [Razavi, 2017] Section 7.4.2 and 7.4.3 (FYI)

# Cascode Amplifier

- ❑ Noise of M2 is negligible because  $V_{out}/V_{n2}$  is much smaller than  $V_{out}/V_{n1}$  (dominant noise contributions from high gain paths)
  - But M2 noise contribution may be large at high frequencies

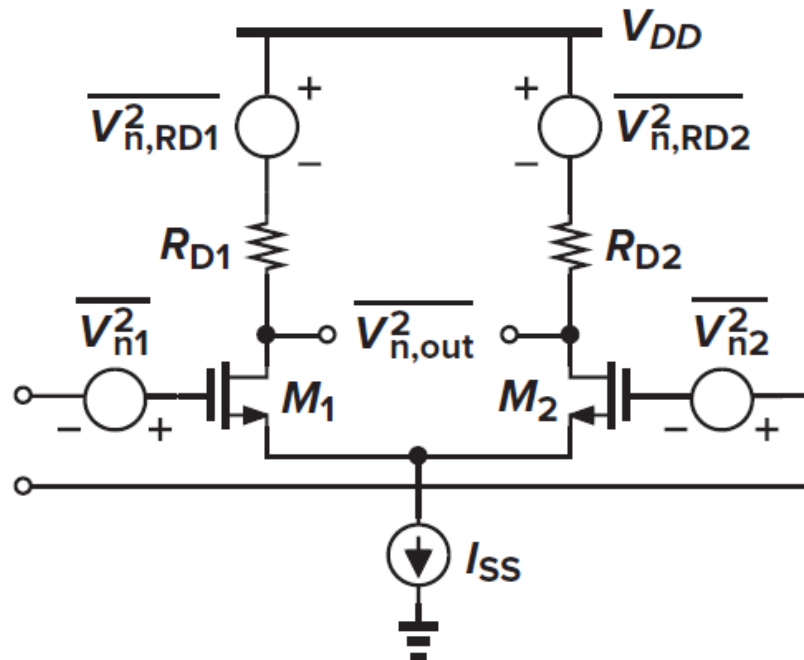
$$\overline{V_{n,in}^2}|_{M1,RD} = 4kT \left( \frac{\gamma}{g_{m1}} + \frac{1}{g_{m1}^2 R_D} \right)$$



# Differential Pair with Resistive Load

- Twice the noise density of a CS amplifier (and twice the power consumption)

$$\overline{V_{n,in,tot}^2} = 8kT \left( \frac{\gamma}{g_m} + \frac{1}{g_m^2 R_D} \right) + \frac{2K}{C_{ox} W L} \frac{1}{f}$$

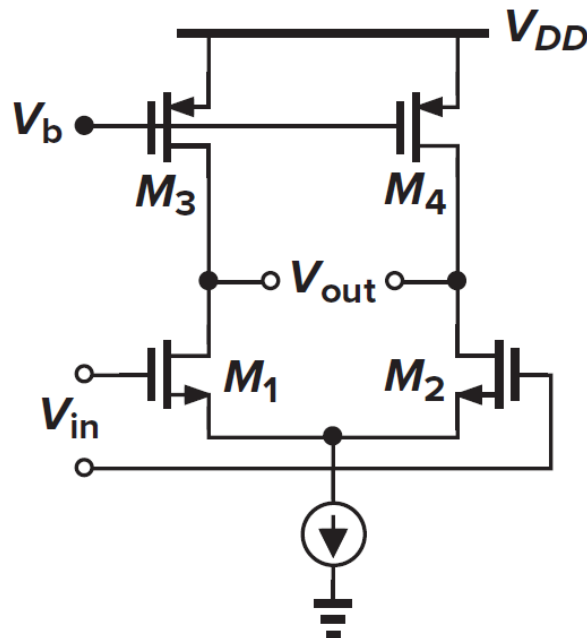


# Differential Pair with Active Load

- ❑ Noise sources of M1 and M2 are already input referred
- ❑ Noise of M3 and M4 can be viewed as noise of PMOS input pair

$$\overline{V_{n,in}^2} = 2\overline{V_{n1}^2} + 2\frac{g_{m3}^2}{g_{m1}^2}\overline{V_{n3}^2}$$

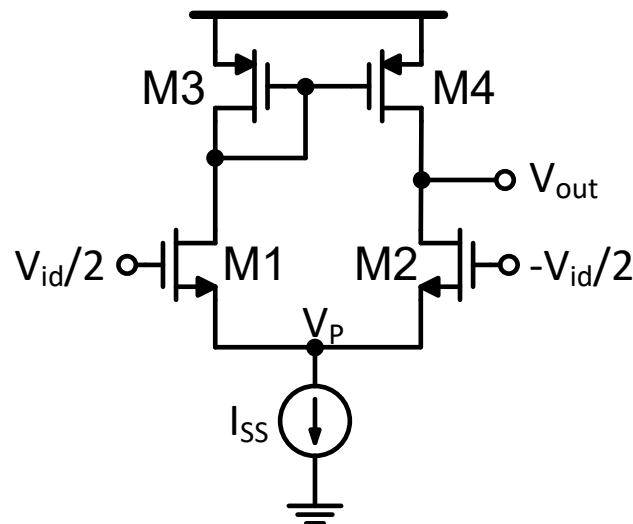
$$\overline{V_{n,in}^2} = 8kT\gamma \left( \frac{1}{g_{m1}} + \frac{g_{m3}}{g_{m1}^2} \right) + \frac{2K_N}{C_{ox}(WL)_1 f} + \frac{2K_P}{C_{ox}(WL)_3 f} \frac{g_{m3}^2}{g_{m1}^2}$$



# Differential Pair with CM Load (5T OTA)

- ❑ Noise sources of M1 and M2 are already input referred
- ❑ M3 is diode connected:  $V_{n3}$  in series with  $1/g_{m3}$ 
  - Drain of M1 is H.I.N.:  $V_{gs4} \approx V_{n3}$
- ❑ Same as last slide:  $\overline{V_{n,in}^2} = 2\overline{V_{n1}^2} + 2\frac{g_{m3}^2}{g_{m1}^2}\overline{V_{n3}^2}$

$$\overline{V_{n,in}^2} = 8kT\gamma \left( \frac{1}{g_{m1}} + \frac{g_{m3}}{g_{m1}^2} \right) + \frac{2K_N}{C_{ox}(WL)_1 f} + \frac{2K_P}{C_{ox}(WL)_3 f} \frac{g_{m3}^2}{g_{m1}^2}$$

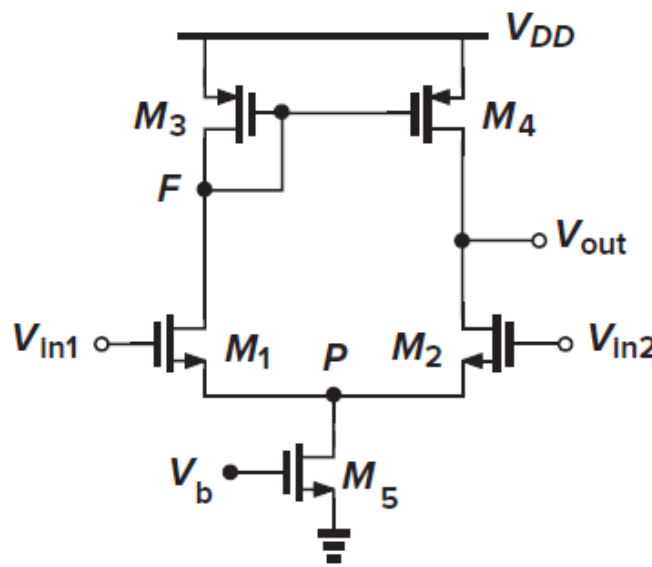


# Differential Pair with CM Load (5T OTA)

- ❑ Noise of tail current source appears at output, even if we assume perfect matching
  - $V_{out}$  and  $V_X$  respond similarly to CM input  $\rightarrow R_{out} = 1/g_{m3}$
- ❑ Noise of tail current source split equally between M1 and M2

$$V_{n,in,M5}^2 = \left(\frac{V_{n5}}{2}\right)^2 \cdot g_{m5}^2 \cdot \frac{1}{g_{m3}^2} \cdot \frac{1}{g_{m1}^2 (r_{o2} // r_{o4})^2}$$

- ❑ This noise component is relatively negligible



# Differential Pair: Design for Low Noise

$$\overline{V_{n,in}^2} = 8kT\gamma \left( \frac{1}{g_{m1}} + \frac{g_{m3}}{g_{m1}^2} \right) + \frac{2K_N}{C_{ox}(WL)_1 f} + \frac{2K_P}{C_{ox}(WL)_3 f} \frac{g_{m3}^2}{g_{m1}^2}$$

□ Thermal noise:  $V_{n,in}^2 = \frac{8kT\gamma}{g_{m1}} \left( 1 + \frac{g_{m3}}{g_{m1}} \right)$

- Maximize  $g_{m1} \rightarrow I_D \uparrow \rightarrow$  power consumption  $\uparrow$
- Minimize  $g_{m3} \rightarrow V_{ov3} \uparrow \rightarrow$  headroom  $\downarrow$

□ Flicker noise:  $V_{n,in}^2 = \frac{2K_N}{C_{ox}W_1L_1} \frac{1}{f} + \frac{2K_PL_1}{C_{ox}W_1L_3^2} \frac{\mu_p}{\mu_n} \frac{1}{f}$

$$V_{n,in,rms}^2 = \frac{2}{C_{ox}W_1} \left( \frac{K_N}{L_1} + \frac{K_PL_1}{L_3^2} \frac{\mu_p}{\mu_n} \right) \ln \frac{f_{max}}{f_{min}}$$

- If  $L_1 = L_3$ : NMOS input pair dominates since  $K_N > K_P$  and  $\mu_n > \mu_p$
- $W_{3,4}$  has no effect
- Increase  $W_1 \rightarrow I_D \uparrow$  (if  $V_{ov}$  is constant)  $\rightarrow$  power consumption  $\uparrow$
- Increase  $L_3 \rightarrow V_{ov3} \uparrow \rightarrow$  headroom  $\downarrow \rightarrow$  also area and parasitics  $\uparrow$



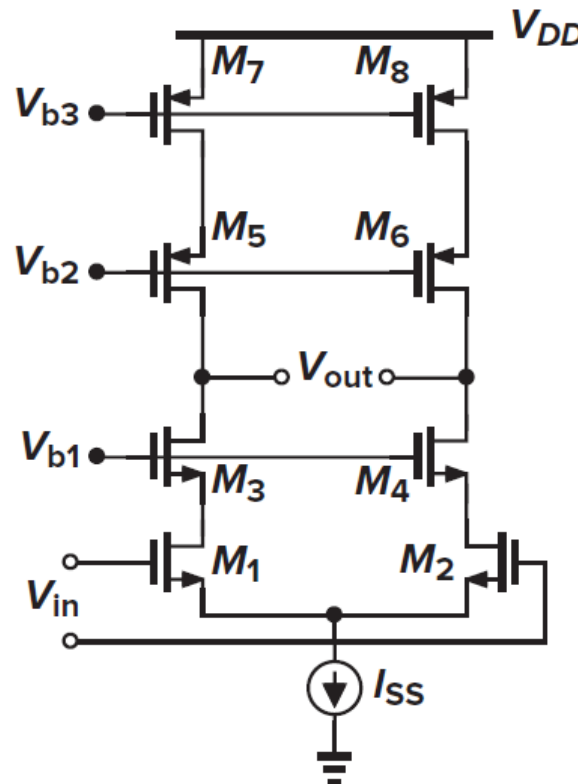
# Noise in OTAs

- ❑ In all OTA topologies, at least four devices contribute to the input noise: two input transistors and two “load” transistors
- ❑ Quick check to determine if a transistor dominant noise contributors:
  - Estimate the gain from the gate of the transistor to the output: is it comparable to the gain from the input to the output?

# Telescopic Cascode

- ❑ The noise of the cascode devices is negligible at low frequencies
- ❑ M1–M2 and M7–M8 are the primary noise sources

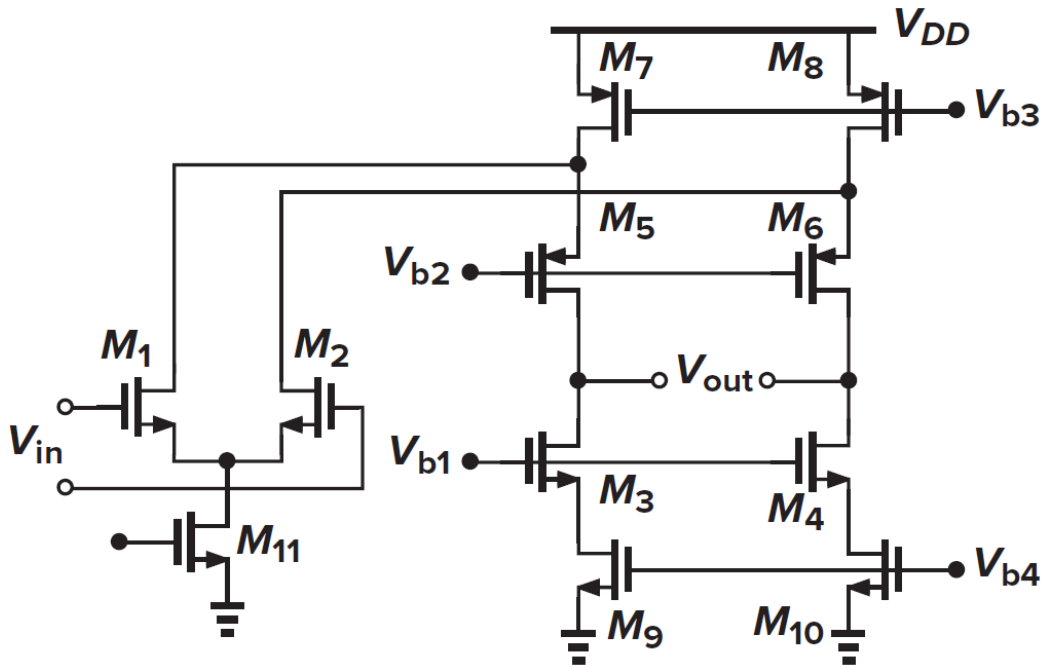
$$\overline{V_n^2} = 4kT \left( 2 \frac{\gamma}{g_{m1,2}} + 2 \frac{\gamma g_{m7,8}}{g_{m1,2}^2} \right) + 2 \frac{K_N}{(WL)_{1,2} C_{ox} f} + 2 \frac{K_P}{(WL)_{7,8} C_{ox} f} \frac{g_{m7,8}^2}{g_{m1,2}^2}$$



# Folded Cascode

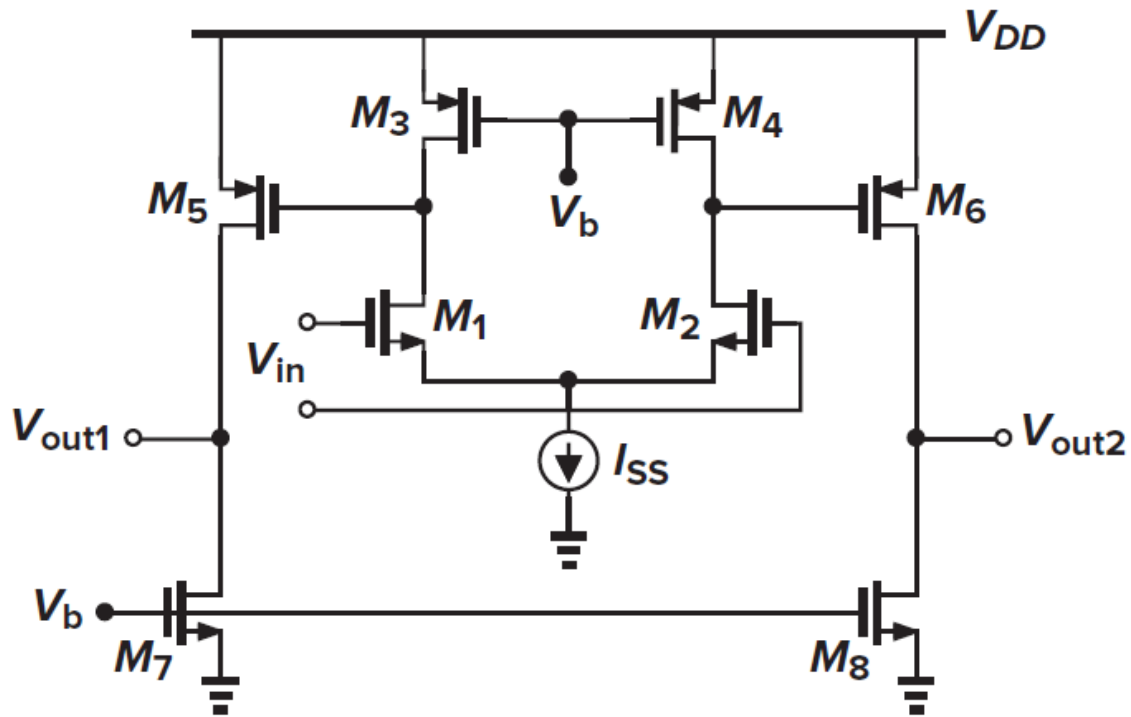
- ❑ The noise of the cascode devices is negligible at low frequencies
- ❑ M1–M2, M7–M8, and M9–M10 are the primary noise sources

$$\overline{V_{n,int}^2} = 8kT \left( \frac{\gamma}{g_{m1,2}} + \gamma \frac{g_{m7,8}}{g_{m1,2}^2} + \gamma \frac{g_{m9,10}}{g_{m1,2}^2} \right)$$



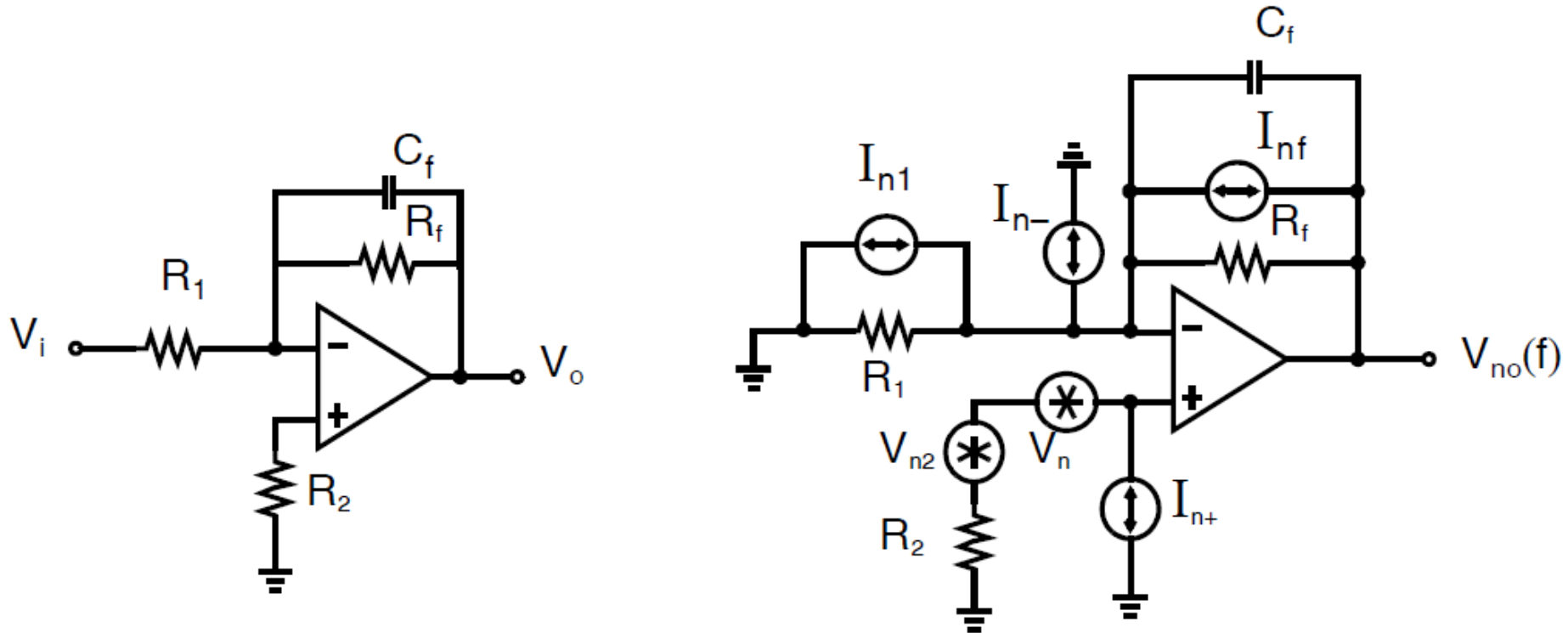
# Two-Stage OTA

- ❑ The noise resulting from the second stage is usually negligible because it is divided by the gain of the first stage when referred to the main input



# Noise in Closed Loop OTA / Op-Amp Circuits

- ❑ Example: Inverting amplifier ( $R_f$  and  $R_1$ ) and LPF ( $R_f$  and  $C_f$ )
- ❑  $V_n$ ,  $I_{n-}$ , and  $I_{n+}$  model the op-amp equivalent input noise
- ❑ HW: Read Section 9.4.1 and solve Example 9.10 in Johns and Martin

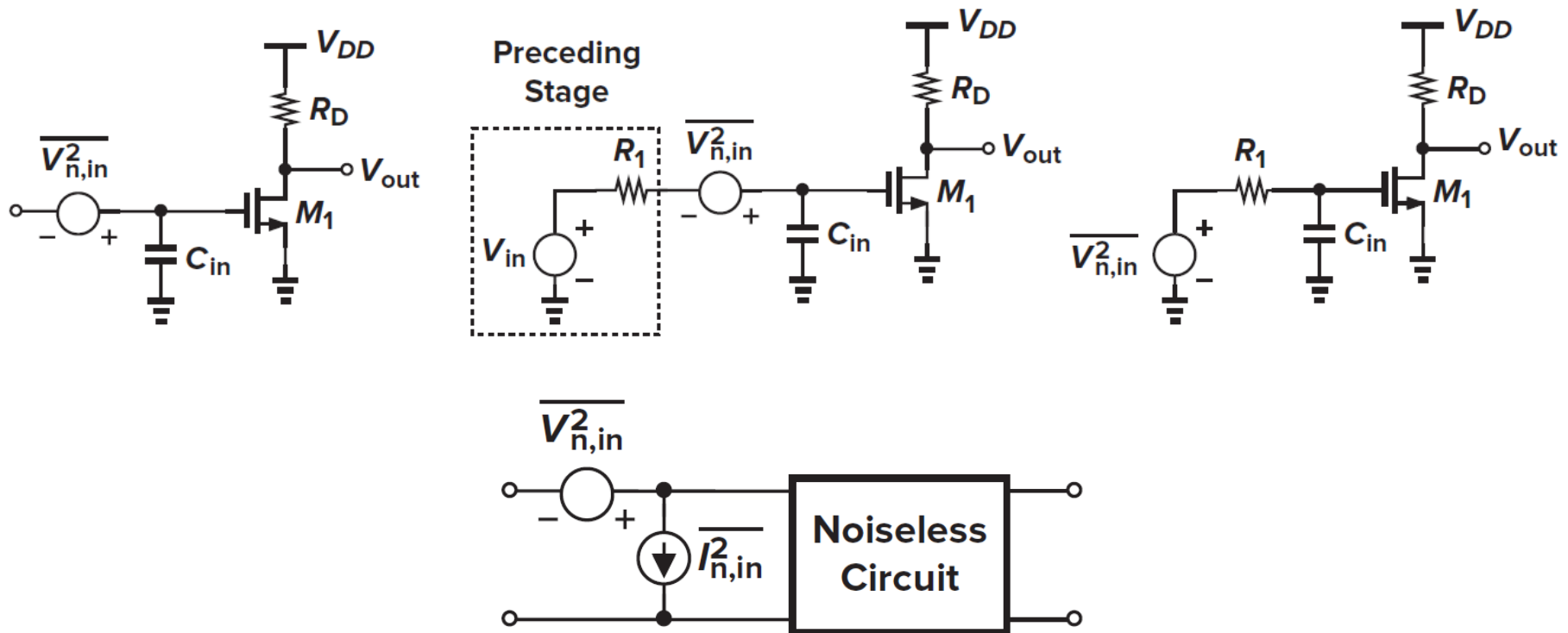


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**Thank you!**

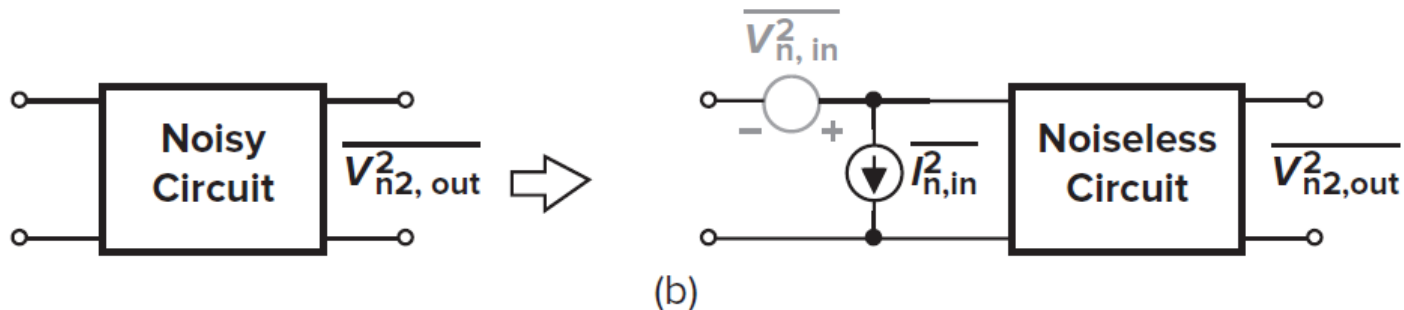
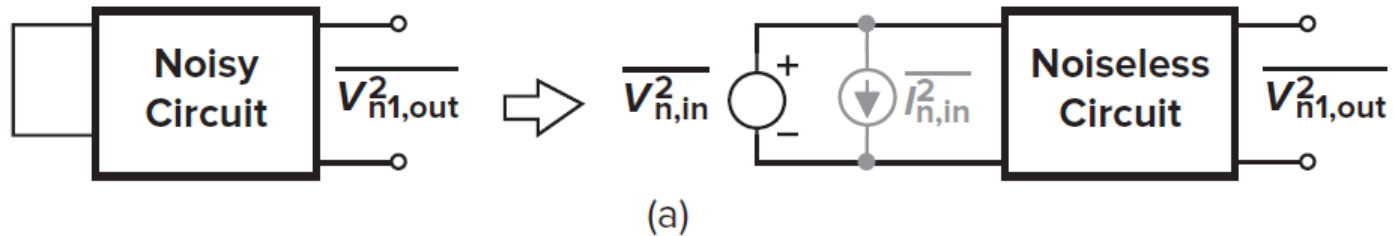
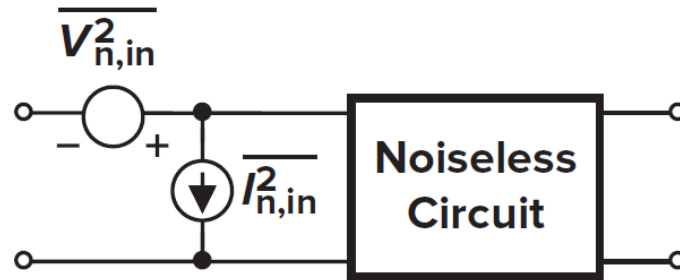
# Input-Referred Noise

- ❑ The noise due to  $M_1$  channel should be independent of the source impedance  $R_1 \rightarrow$  If  $R_1 \rightarrow \infty$  output noise is zero!!!
- ❑ Modeling the noise by  $V_{n,in}^2$  alone is not sufficient
- ❑ A complete model can be provided by  $V_{n,in}^2$  and  $I_{n,in}^2$



# Input-Referred Noise

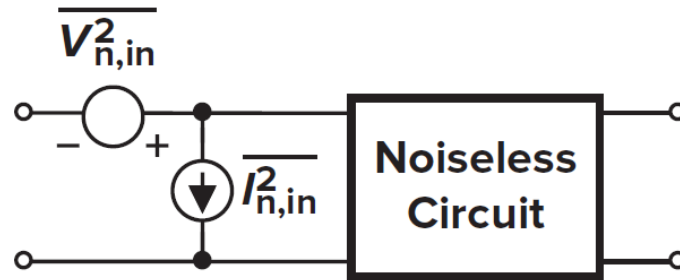
- ❑ Zero source impedance  $\rightarrow$  Calculate  $V_{n,in}^2$
- ❑ Infinite source impedance  $\rightarrow$  Calculate  $I_{n,in}^2$



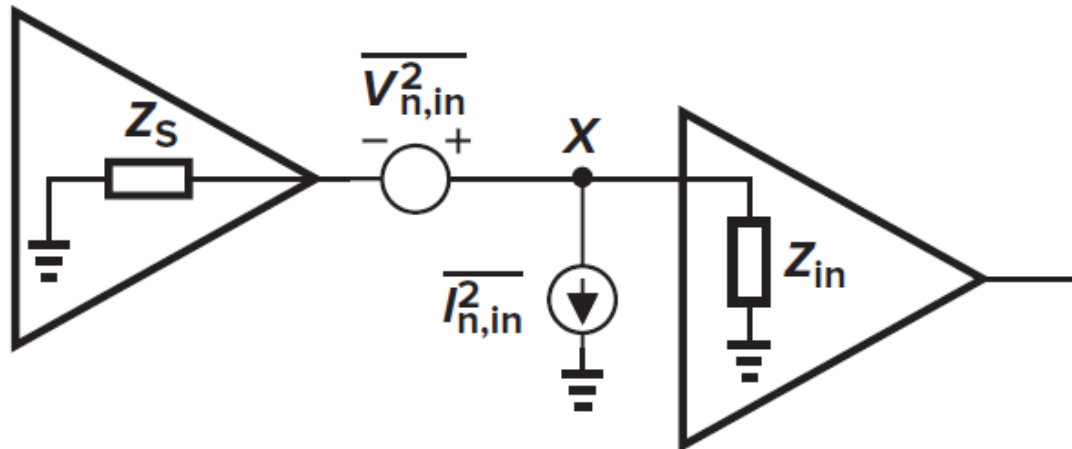


# Input-Referred Noise

- ❑ Zero source impedance  $\rightarrow$  Calculate  $V_{n,in}^2$
- ❑ Infinite source impedance  $\rightarrow$  Calculate  $I_{n,in}^2$



$$V_{n,X} = \frac{Z_{in}}{Z_{in} + Z_S} V_{n,in} + \frac{Z_{in} Z_S}{Z_{in} + Z_S} I_{n,in}$$

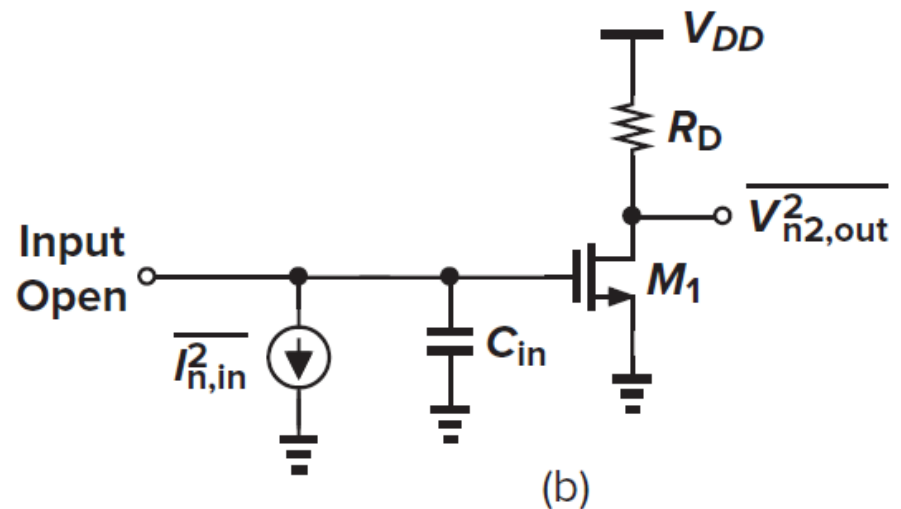
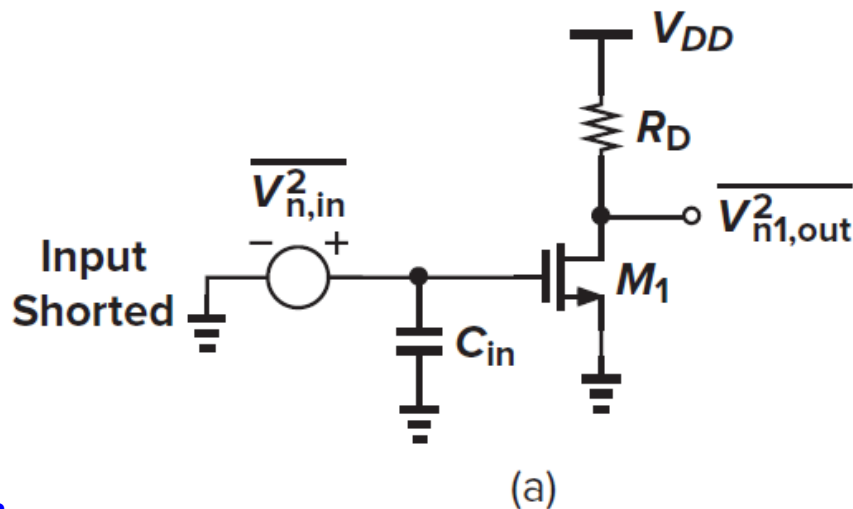


# Ex: Input-Referred Noise in CS Amplifier

$$\overline{V_{n,in}^2} = 4kT \frac{\gamma}{g_m} + \frac{4kT}{g_m^2 R_D}$$

$$\overline{V_{n2,out}^2} = \overline{I_{n,in}^2} \left( \frac{1}{C_{in}\omega} \right)^2 g_m^2 R_D^2 = \left( 4kT \gamma g_m + \frac{4kT}{R_D} \right) R_D^2$$

$$\overline{I_{n,in}^2} = (C_{in}\omega)^2 \frac{4kT}{g_m^2} \left( \gamma g_m + \frac{1}{R_D} \right)$$



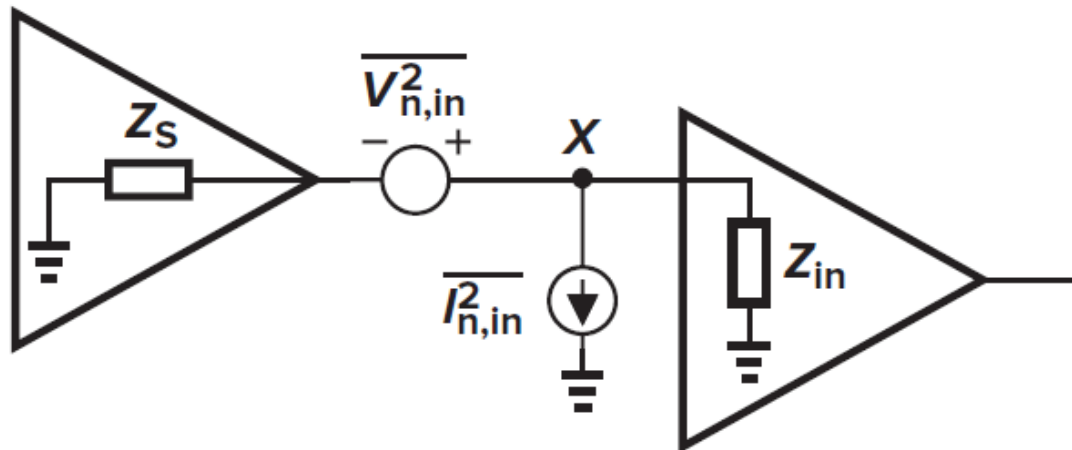
# Input-Referred Noise

$$V_{n,X} = \frac{Z_{in}}{Z_{in} + Z_S} V_{n,in} + \frac{Z_{in} Z_S}{Z_{in} + Z_S} I_{n,in}$$

□  $I_{n,in}^2$  can be neglected if

$$\overline{I_{n,in}^2} |Z_S|^2 \ll \overline{V_{n,in}^2} \quad \rightarrow \quad |Z_S|^2 \ll \frac{\overline{V_{n,in}^2}}{\overline{I_{n,in}^2}}$$

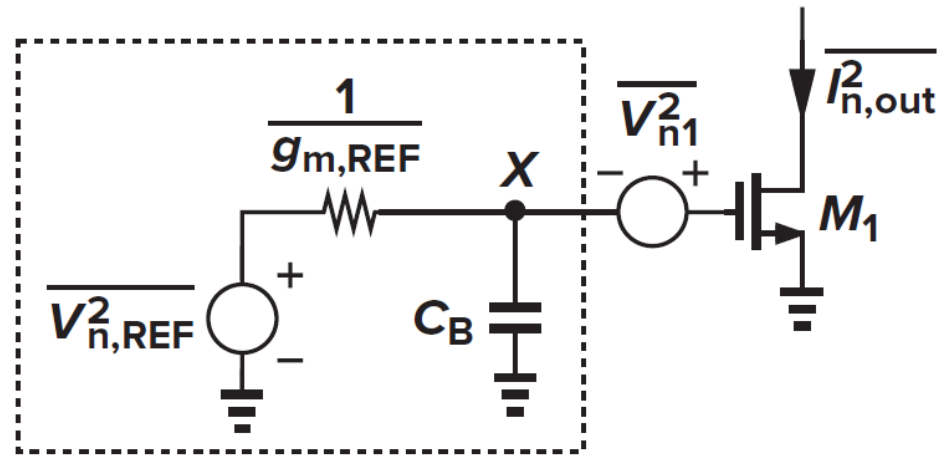
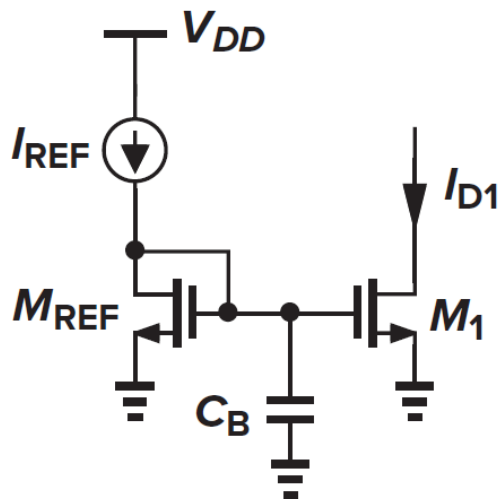
□ It is all about the output impedance of the preceding stage



# Current Mirror

- ❑ The diode-connected device may contribute substantial flicker noise unless an extremely large bypass capacitor is used
- ❑ Let  $(W/L)_{REF} = \frac{1}{N} (W/L)_1 \rightarrow V_{n,REF}^2 = N V_{n1}^2$  (flicker noise  $\propto \frac{1}{WL}$ )

$$\overline{I_{n,out}^2} = \left( \frac{g_{m,REF}^2}{C_B^2 \omega^2 + g_{m,REF}^2} \overline{V_{n,REF}^2} + \overline{V_{n1}^2} \right) g_{m1}^2 = \left( \frac{N g_{m,REF}^2}{C_B^2 \omega^2 + g_{m,REF}^2} + 1 \right) g_{m1}^2 \overline{V_{n1}^2}$$



# Current Mirror

$$\overline{I_{n,out}^2} = \left( \frac{g_{m,REF}^2}{C_B^2 \omega^2 + g_{m,REF}^2} \overline{V_{n,REF}^2} + \overline{V_{n1}^2} \right) g_{m1}^2 = \left( \frac{N g_{m,REF}^2}{C_B^2 \omega^2 + g_{m,REF}^2} + 1 \right) g_{m1}^2 \overline{V_{n1}^2}$$

- ❑ For  $M_{REF}$  contribution to be negligible:  $(N - 1)g_{m,REF}^2 \ll C_B^2 \omega^2$ 
  - Let  $N = 5$ ,  $g_m = 5mS$ , and  $\omega = 1MHz \rightarrow C_B \gg 500pF!!$
- ❑ A resistance  $R_B$  can be used to lower the filter cutoff frequency
  - $R_B$  can be implemented as a MOSFET in triode

